AFE4300 Development Guide

User's Guide

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AFE4300 Development Guide

This user's guide describes the characteristics, operation and use of the AFE4300EVM-PDK demonstration kit. This demonstration kit is an evaluation module for the AFE4300 device. The AFE4300 is an analog-front-end incorporating two separate signal chains; one targeting weight measurement and the other targeting body composition analysis. The AFE4300EVM-PDK is intended for prototyping and evaluation. This user's guide includes a complete circuit description, schematic diagram, and bill of materials (BOM).

The following related documents are available through the Texas Instruments web site at http://www.ti.com.

Related Documentation

Device	Literature Number
AFE4300	SBAS586

1 AFE4300EVM-PDK Overview

1.1 Important Disclaimer Information

CAUTION

The AFE4300EVM-PDK is intended for feasibility and evaluation testing only in laboratory and development environments. This product is not for diagnostic use.

The AFE4300EVM-PDK is to be used only under these conditions:

- The AFE4300EVM-PDK is intended only for electrical evaluation of the features of the AFE4300 device in a laboratory, simulation, or development environment.
- The AFE4300EVM-PDK is not intended for direct interface with a patient, or patient diagnostics.
- The AFE4300EVM-PDK is intended *only* for development purposes. It is not intended to be used as all or part of an end-equipment application.
- The AFE4300EVM-PDK should be used only by qualified engineers and technicians who are familiar with the risks associated with handling electrical and mechanical components, systems, and subsystems.
- The user is responsible for the safety of himself, fellow employees and contractors, and coworkers when using or handling the AFE4300EVM-PDK. Furthermore, the user is fully responsible for the contact interface between the human body and electronics; consequently, the user is responsible for preventing electrical hazards such as shock, electrostatic discharge, and electrical overstress of electric circuit components.

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2 Overview

2.1 Introduction

The AFE4300EVM-PDK demonstration kit is intended for evaluating the AFE4300 device, a low-cost, analog-front-end incorporating two separate signal chains; one targeting weight measurement and the other targeting body composition analysis. The AFE4300EVM-PDK demonstration kit contains the following items:

- AFE4300EVM printed circuit board (PCB)
- MMB3 modular motherboard
- USB cable

The digital SPI™ control interface is provided by the MMB3 board that connects to the AFE4300 evaluation board. The purpose of AFE4300EVM-PDK is to expedite evaluation and system development.

The MMB3 board allows the AFE4300EVM to be connected to the computer through an available USB port. This user guide shows how to use the MMB3 board as part of the AFE4300EVM, but does not provide technical details about the MMB3 board itself.

Throughout this document, the abbreviation EVM and the term evaluation module are synonymous with the AFE4300EVM-PDK.

2.2 Supported Features

1. Support for up to four load-cell inputs.
2. Support for tetrapolar impedance measurements.
3. Onboard load-cell simulation block.
4. Onboard impedance simulation block.
5. Acquire data at up to 860 samples per second (SPS) in data capture mode.
6. USB-based power and PC application connectivity.
7. Analysis tools, including a virtual oscilloscope, histogram, and fast Fourier transform (FFT) on the PC application.
8. Access the AFE4300 registers through an easy-to-use graphical user interface (GUI) PC-based application.

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3 Software Installation

3.1 Minimum Requirements

Before installing the software, verify that your PC meets the minimum requirements outlined in this section.

3.1.1 Required Setup for AFE4300EVM GUI Software

1. PC-compatible computer
2. Pentium III® or Celeron® processor, 866 MHz or equivalent
3. Minimum 256 MB of RAM (512 MB or greater recommended)
4. Hard disk drive with at least 200 MB free space
5. Windows® XP operating system with SP2, or Windows 7 operating system
6. 1280 × 1024 or greater display screen resolution
7. Mouse or other pointing device
8. Available USB input

3.1.2 Additional Requirements for Use with Hardware

1. AFE4300EVM-PDK Demonstration Kit
2. USB cable

3.2 Installing the Software (PC Application)

The GUI software to evaluate the AFE4300 device is available at the Texas Instruments web site at http://www.ti.com

Before installing the software, make sure the AFE4300EVM-PDK is *not* connected to the PC. If using a machine with Windows 7, it is recommended to have administrator rights to avoid problems during installation.

Unzip the installer file to a temporary directory, and then double click *setup.exe* from the *C:\temp\AFE4300 EVM GUI Installer* directory to install the software. Unless otherwise specified during the installation process, the software installs at *C:\Program Files\Texas Instruments\AFE4300 Device GUI*. The installation creates a program menu item (AFE4300 Device GUI under Start → All Programs → Texas Instruments → AFE4300 Device GUI) to execute the software.

Follow these directions to ensure proper installation of the PC application.

Double click on *setup.exe* and the screen as shown in Figure 1 appears. Click *Next* to continue.

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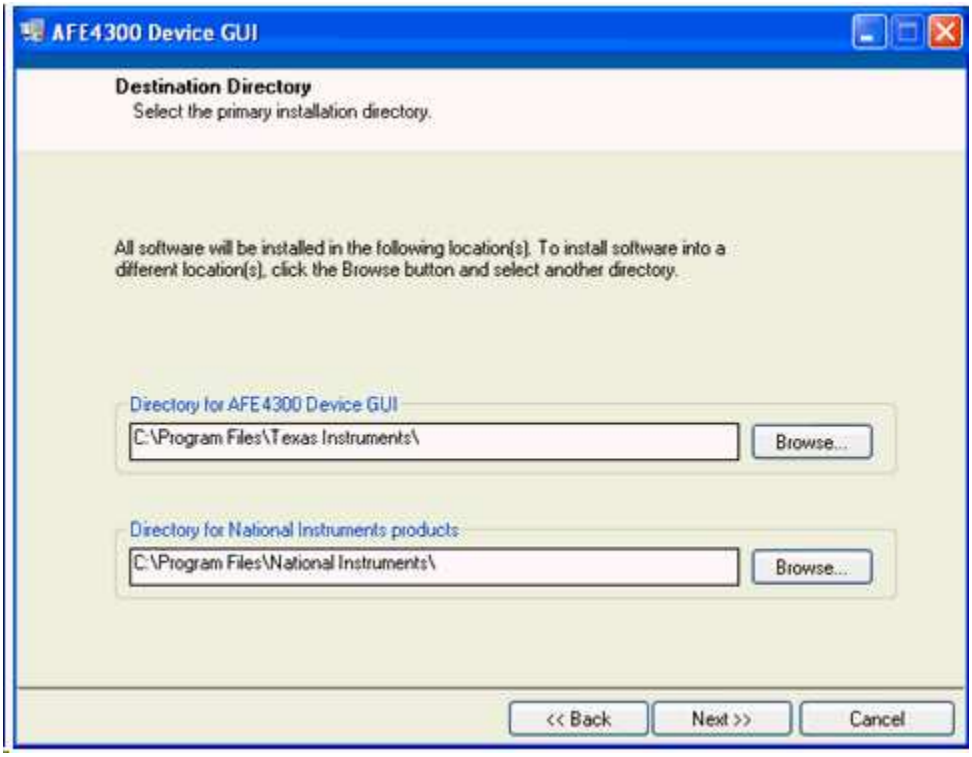

Figure 1. PC Application Installation Screen 1

Accept the GUI License Agreement, as shown in Figure 2, and click *Next* to continue.

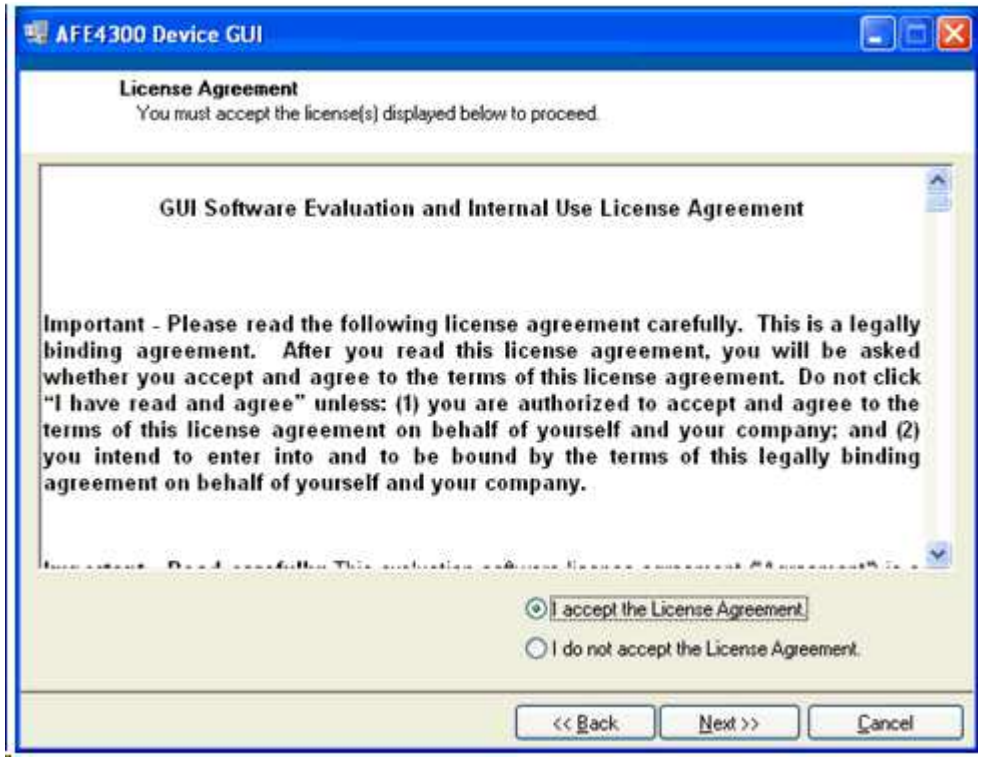

Figure 2. PC Application Installation Screen 2

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Accept the NI and IVI license agreements, as shown in Figure 3, and click *Next* to continue.

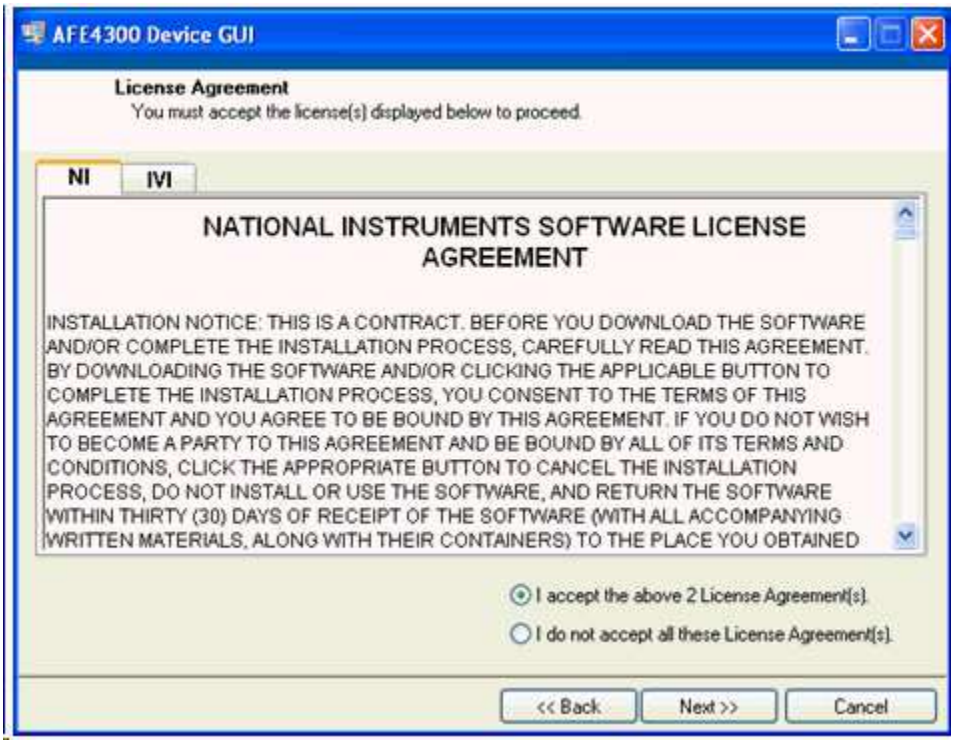

Figure 3. PC Application Installation Screen 3

The next screen in the installation process shows the software files that will be installed on your PC, as shown in Figure 4. Click *Next* to continue.

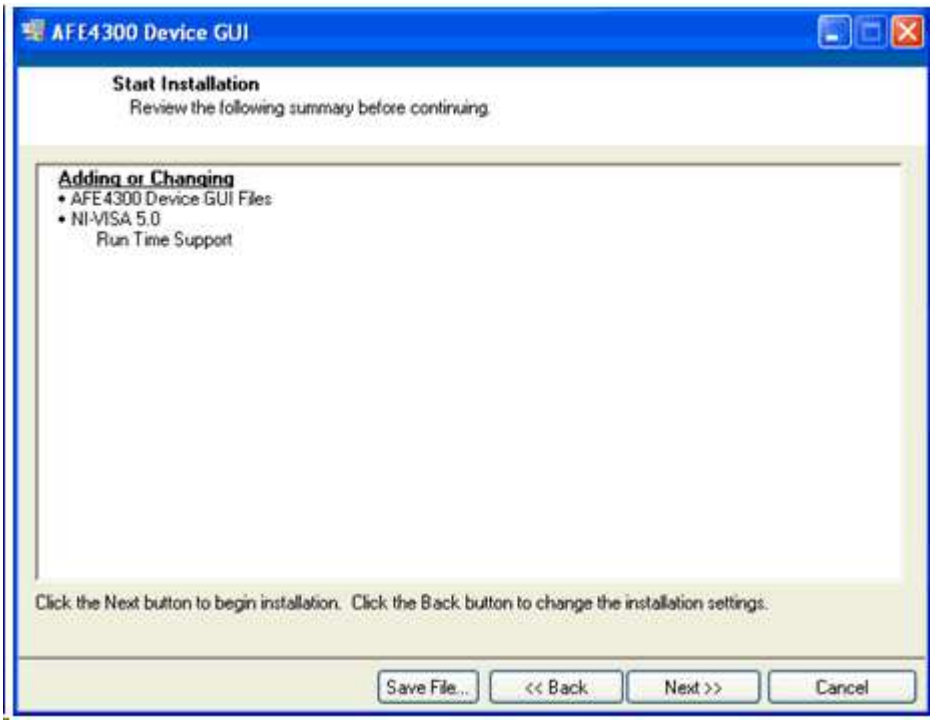

Figure 4. PC Application Installation Screen 4

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The LabVIEW application software is now installed, as shown in Figure 5. Click *Next* to install the USB drivers.

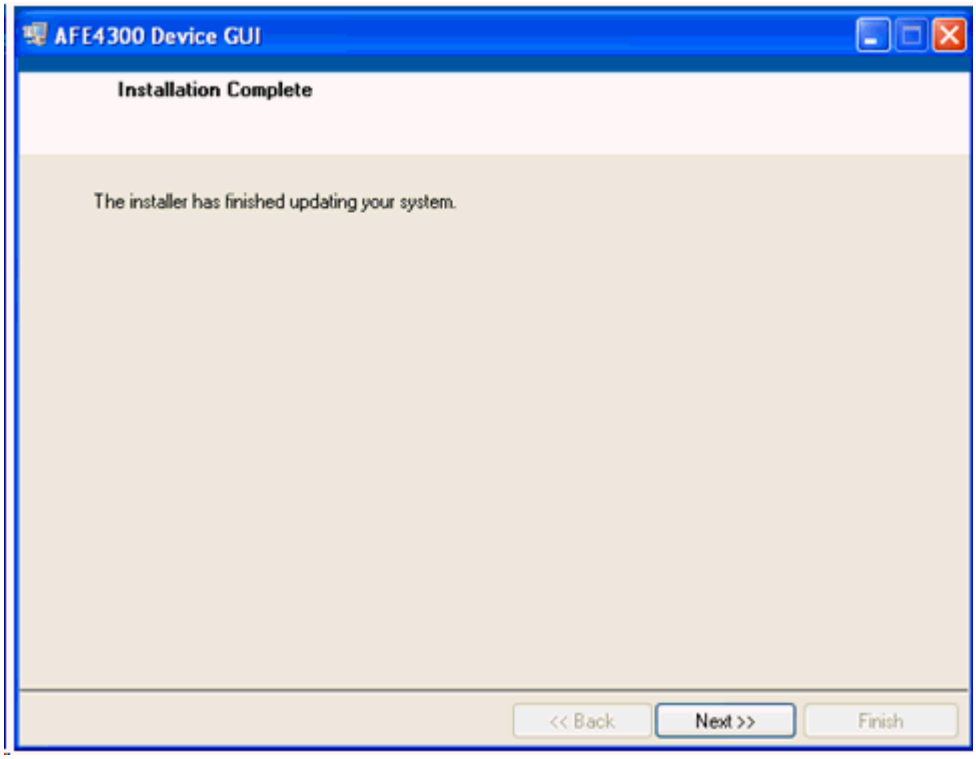

Figure 5. PC Application Installation Screen 5

3.3 Installing the USB Drivers

The communication interface between the AFE4300EVM-PDK and PC is through the USB. A one-time installation of the USB driver is required to enable communication between AFE4300EVM-PDK and PC application.

The following steps ensure proper installation of the USB drivers. Figure 6 shows a dialog box notification that the TUSB3410 single driver installation is about to start. Click *OK* to continue.

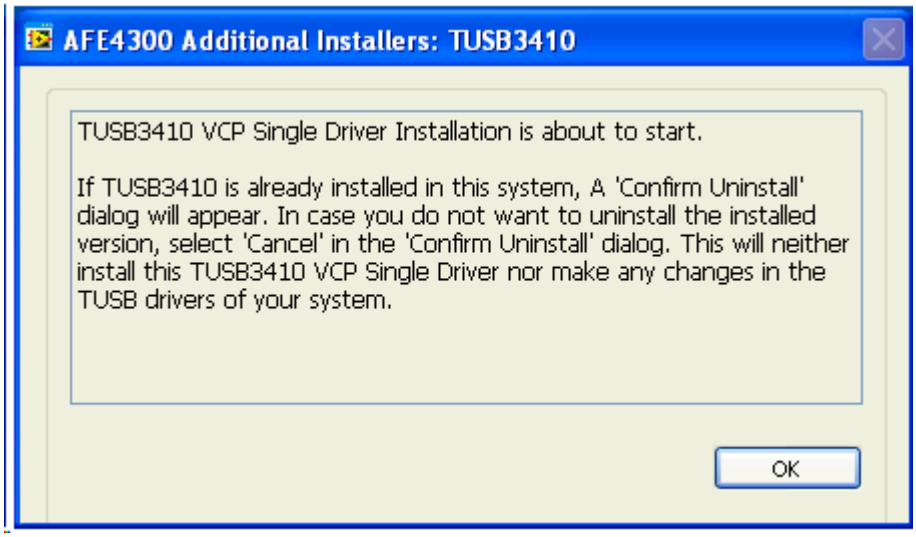

Figure 6. USB Driver Installation Wizard Screen 1

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The InstallShield Wizard prompts about the installation of TUSB3410 on your computer, as shown in Figure 7. Click *Next* to continue.

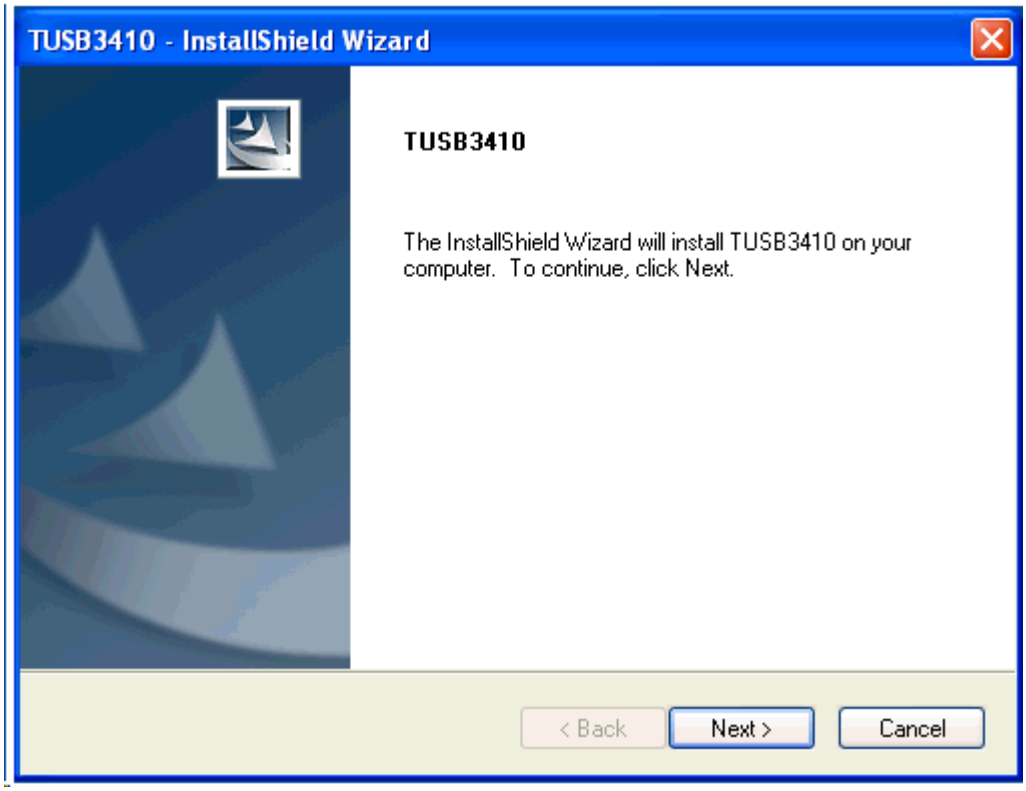

Figure 7. USB Driver Installation Wizard Screen 2

Accept the VCP Driver License Agreement, as shown in Figure 8 and click *Next* to continue. The progress of the installation of the USB drivers is shown in Figure 9.

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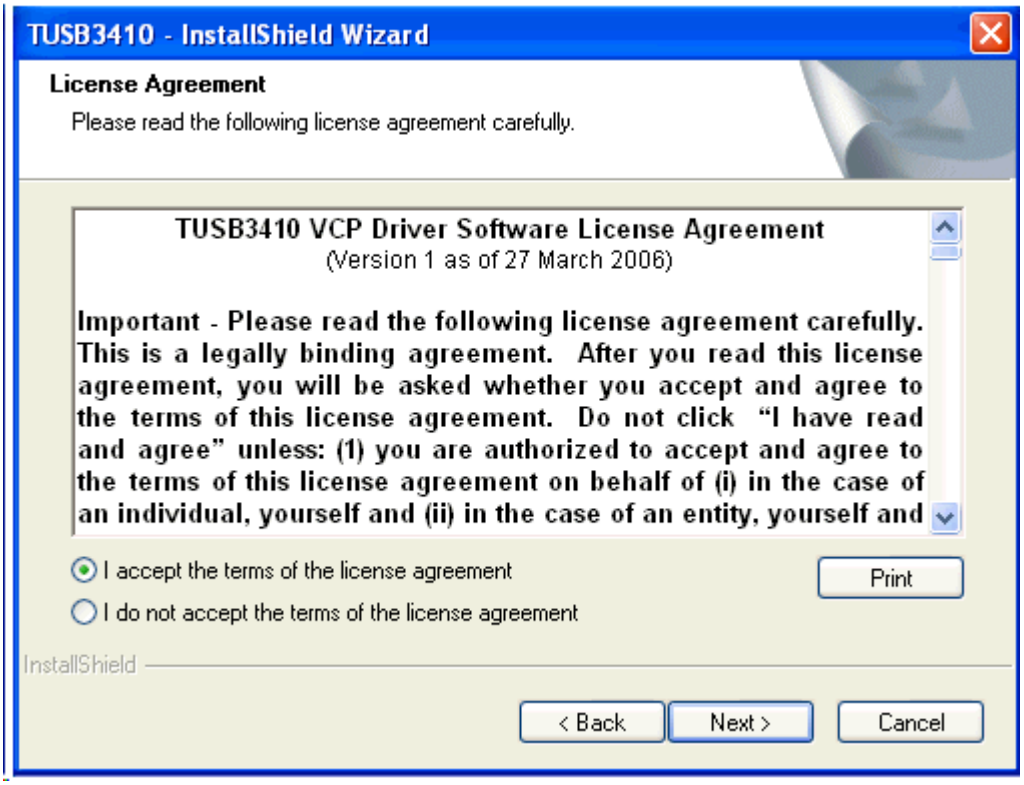

Figure 8. USB Driver Installation Wizard Screen 3

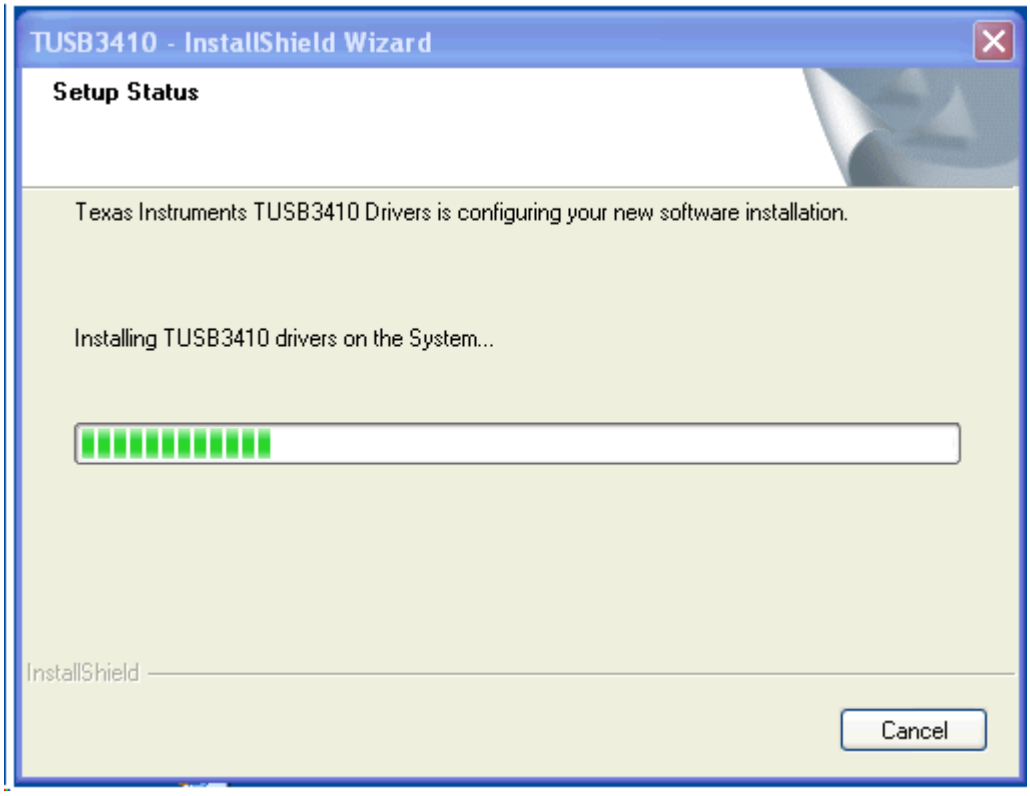

Figure 9. USB Driver Installation Wizard Screen 4

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Click on *Finish* to complete the installation of the USB drivers on your computer, as shown in Figure 10. The AFE4300EVM-PDK is now ready to use.

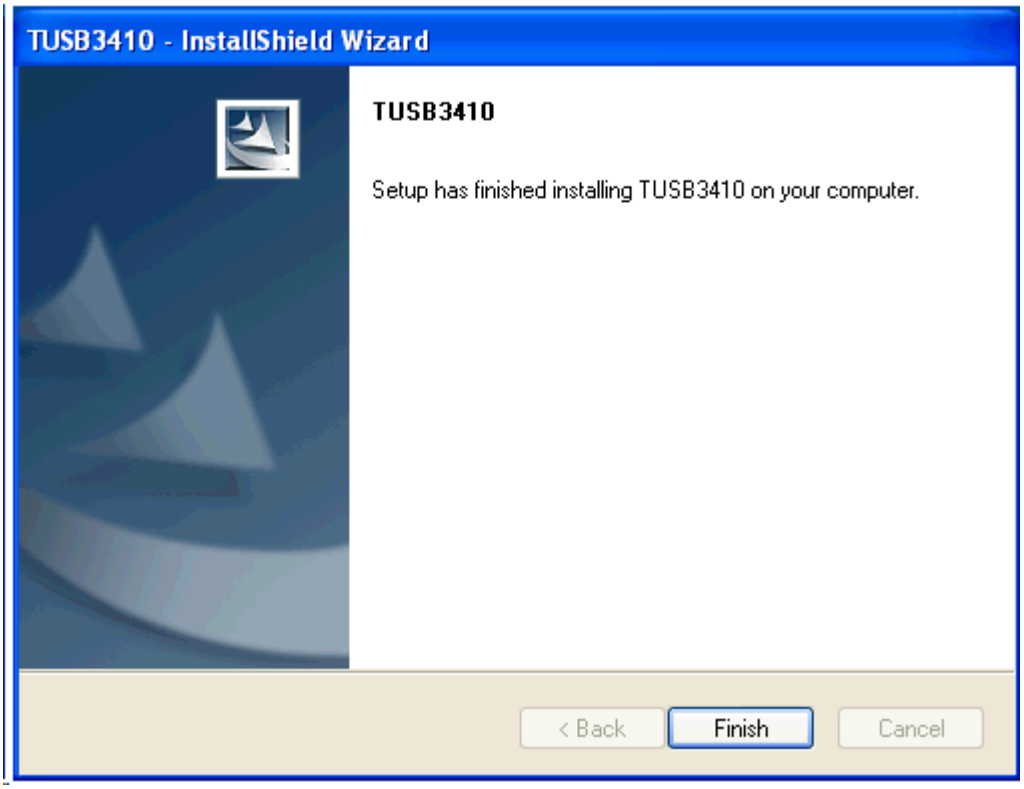

Figure 10. USB Driver Installation Wizard Screen 5

Plug one end of the USB cable to the J1 connector on the MMB3 board, and the other end into the USB port on the PC.

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The TUSB3410 device on the MMB3 board is now recognized as the Virtual COM port under the Device Manager (Start → Control Panel → System → Hardware → Device Manager → Ports (COM & LPT)). An example COM port is shown in Figure 11.

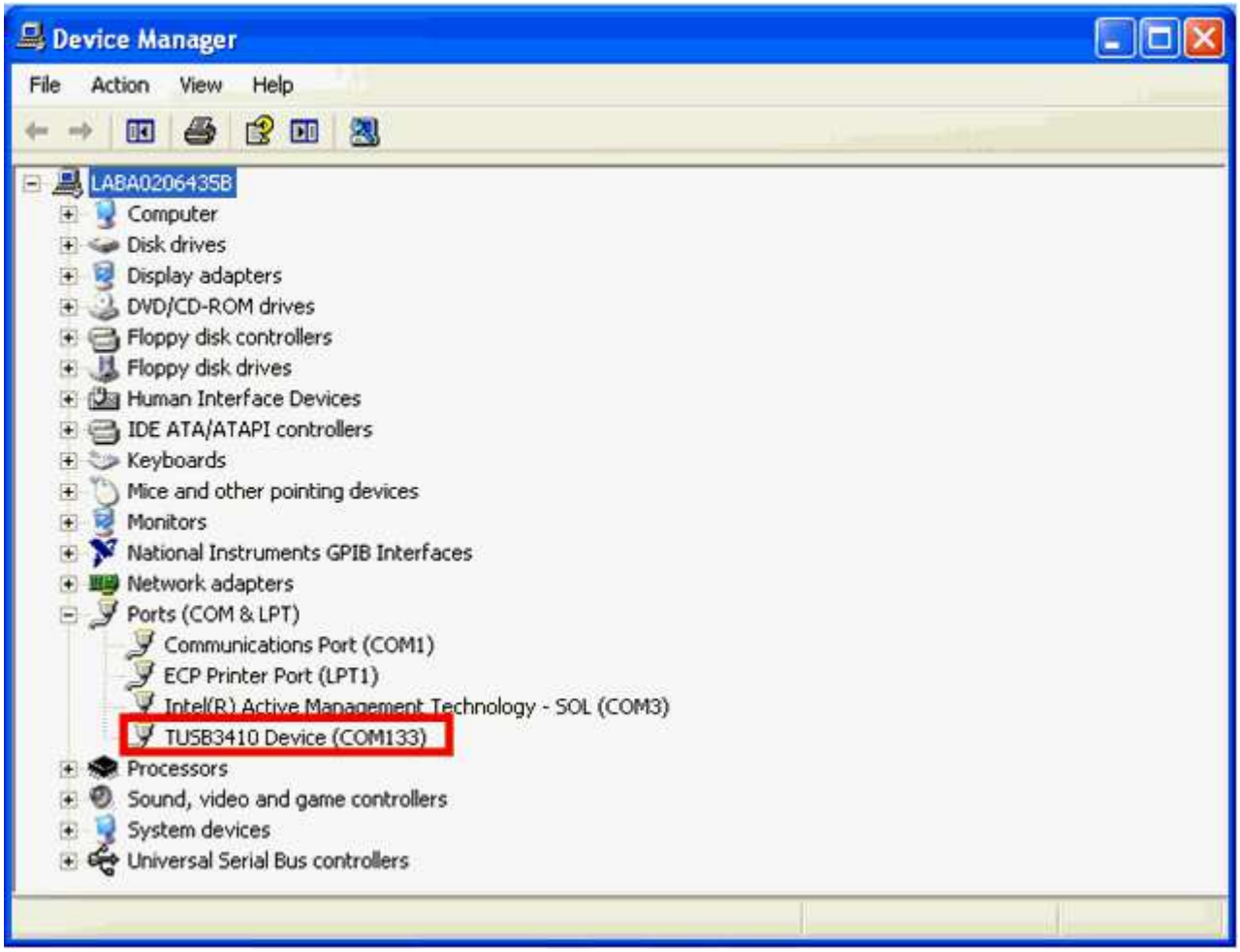

Figure 11. Device Manager Screen

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4 Using the Software: AFE4300 Device GUI and Control Registers

From the Start menu, select *All programs → Texas Instruments → AFE4300 Device GUI* to run the AFE4300EVM GUI software. Unless the hardware has been disconnected, the user will see messages that confirm that the connection has been established and the program is waiting in idle mode for user input.

If the connection to the AFE4300 board is not established, then the program prompts the user to check the connection between the PC and AFE4300EVM and retry, as shown in Figure 12.

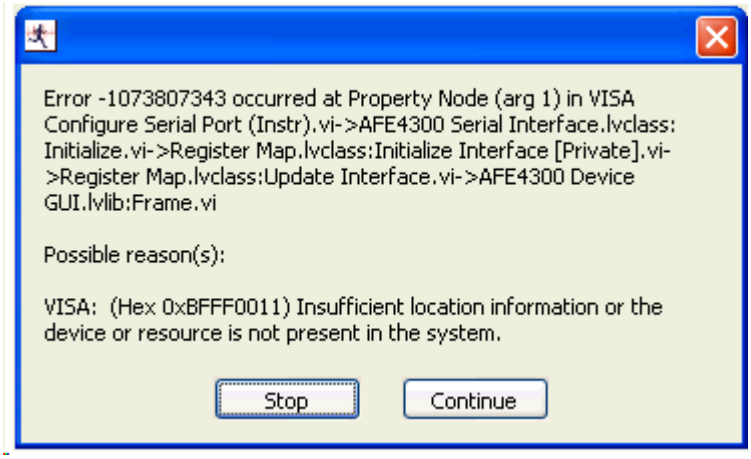

Figure 12. EVM Not Connected to USB Error Message

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4.1 Overview of the Features

This section provides a quick overview of the various features and functions of the AFE4300 device GUI software package.

There are four primary tabs:

- **Device Configuration:** Used to configure all the AFE4300 user registers in a series of related subtabs.
  - Global Settings
  - Weight Scale Controls
  - BCM Controls
  - ADC Controls
  - Low Level Configuration
- **ADC Capture and Analysis:** Used to view and analyze the raw data.
- **About:** Product safety warnings, restrictions, and disclaimers. (see Figure 13)
- **Save:** Used to write data samples and analysis results to a file.

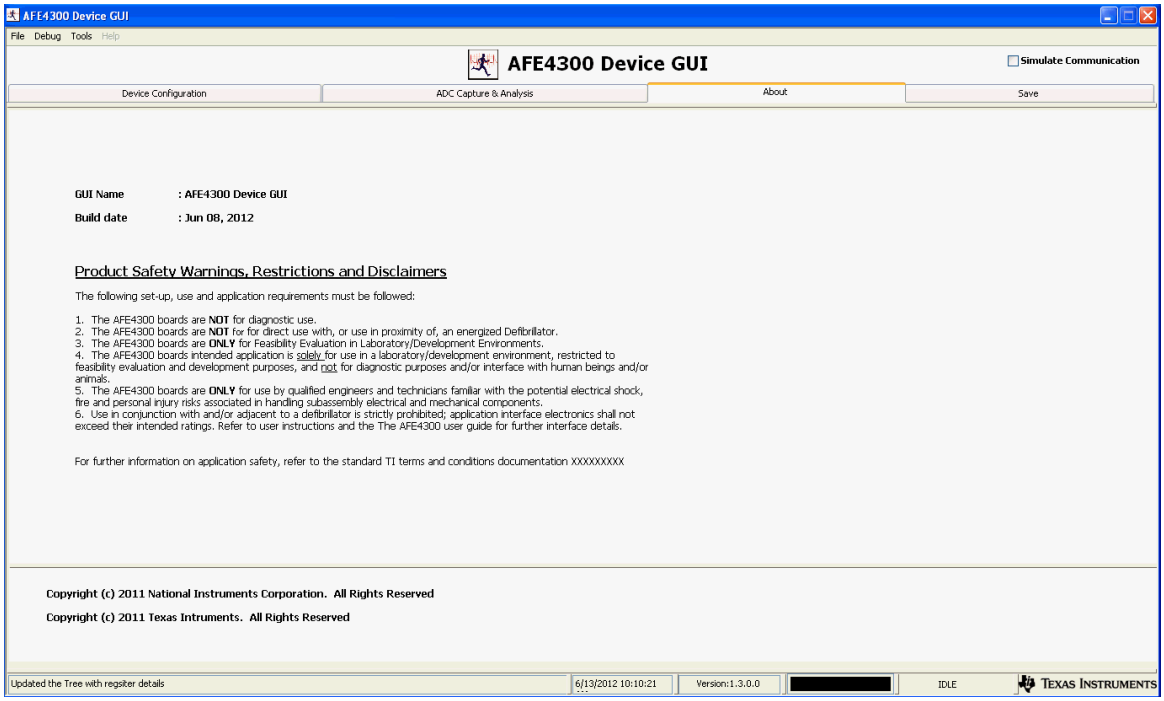

Figure 13. Product Safety Warnings, Restrictions, and Disclaimers

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4.1.1 Device Configuration Tab

The *Device Configuration* tab is used to configure the AFE4300 device. This tab contains five subtabs: Global Settings, Weight Scale Controls, BCM Controls, ADC Controls, and Low Level Configuration.

4.1.1.1 Global Settings Subtab

The *Global Settings* subtab has following features:

1. *Reset To EVM Defaults* button that is used to reset the device and set up the board to the EVM default register settings.
2. Enables the user:
   (a) To modify the clock frequency provided externally,
   (b) To modify the external V_{REF}, and
   (c) To turn on the device.

The *Global Settings* subtab is shown in Figure 14.

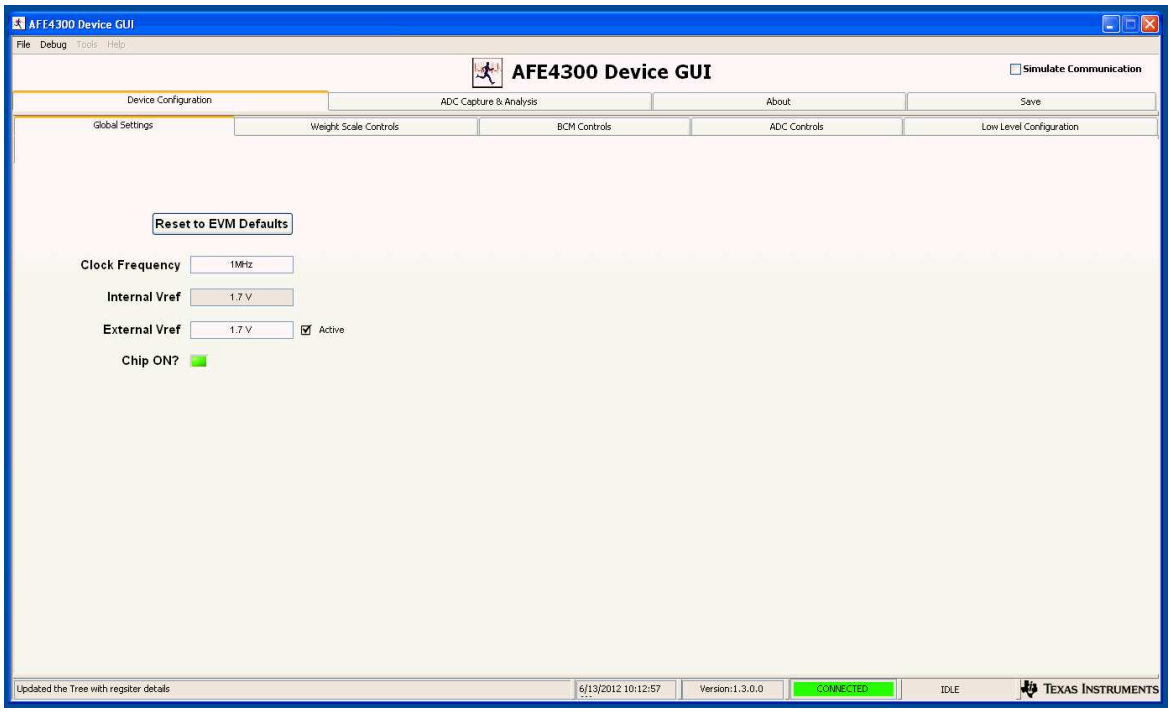

Figure 14. Device Configuration: Global Settings

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4.1.1.2 Weight Scale Controls Subtab

The *Weight Scale Controls* subtab under the *Device Configuration* tab is a user-configurable graphical representation of the weight-scale front-end controls, allowing the user to:

- Turn on and off the weight-scale front-end chain.
- Select the four weight-scale channels.
- Turn on and off the digital-to-analog converter (DAC).
- Set the 6-bit DAC offset.
- Select the gain of the second stage.

The *Weight Scale Controls* subtab is shown in Figure 15.

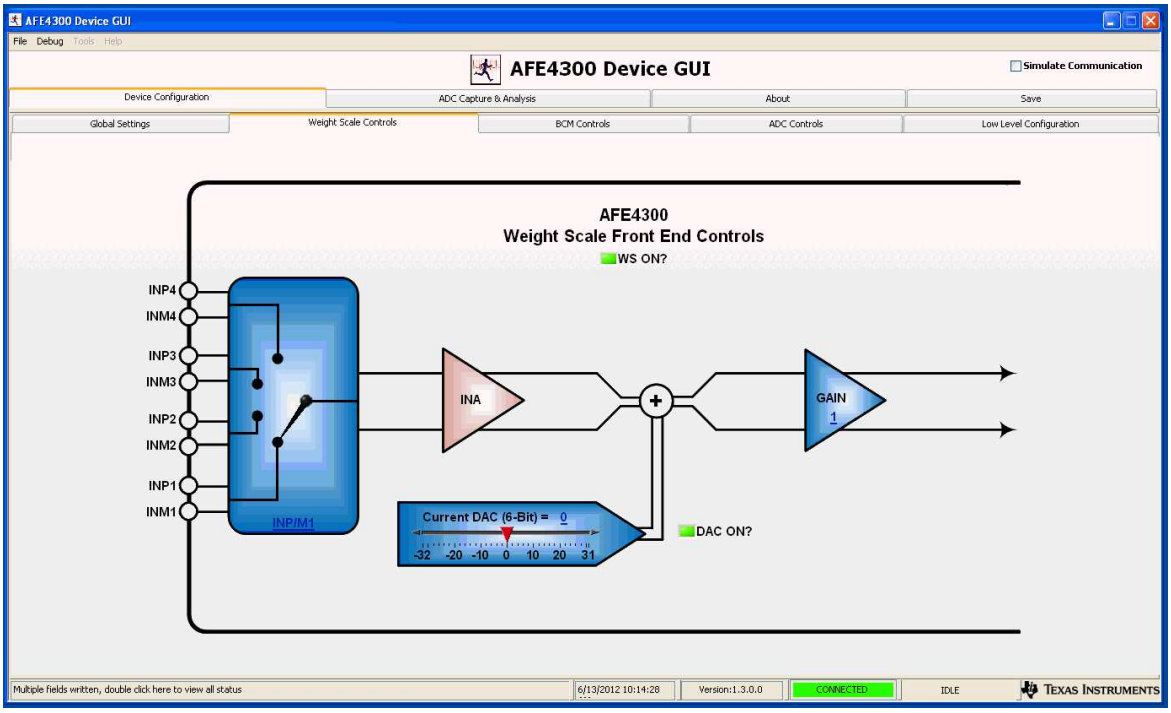

Figure 15. Device Configuration: Weight Scale Front-End Controls

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4.1.1.3 BCM Controls Subtab

The *BCM Controls* subtab under the *Device Configuration* tab is a user-configurable graphical representation of the body composition measurement (BCM) front-end controls. allowing the user to:

- Turn on and off the BCM front-end chain.
- Select the impedance channels to inject the sinusoidal current.
- Select the impedance channels to measure the voltage potential.
- Select the full-wave rectifier or I/Q demodulator.
- Select the code for the direct digital synthesizer (DDS).

The *BCM Controls* subtab is shown in Figure 16.

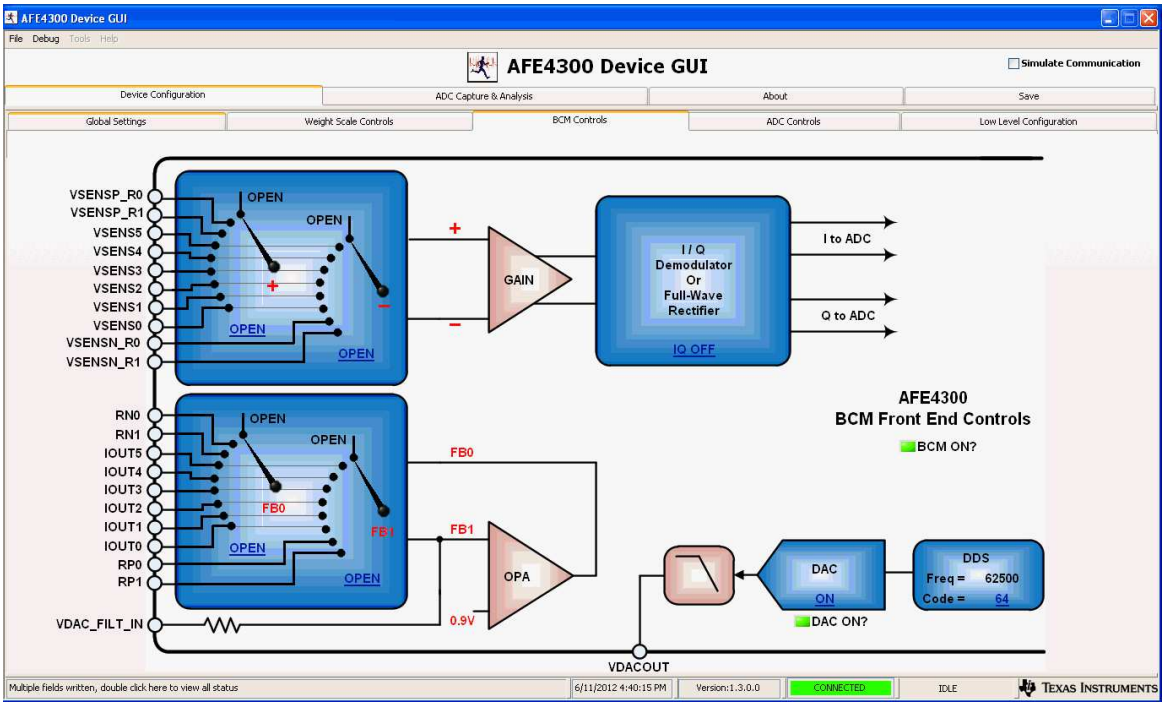

Figure 16. Device Configuration: BCM Front-End Controls

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4.1.1.4 ADC Controls Subtab

The *ADC Controls* subtab under the *Device Configuration* tab is a user-configurable graphical representation of the AFE4300 analog-to-digital converter (ADC) Controls, allowing the user to:

- Turn on and off the ADC.
- Select the gain of the ADC.
- Select the data rate for the decimation filter.
- Select any of the AUX, WS, BCM I, and BCM Q channels.
- Enable battery monitoring.

The *ADC Control* subtab is shown in Figure 17.

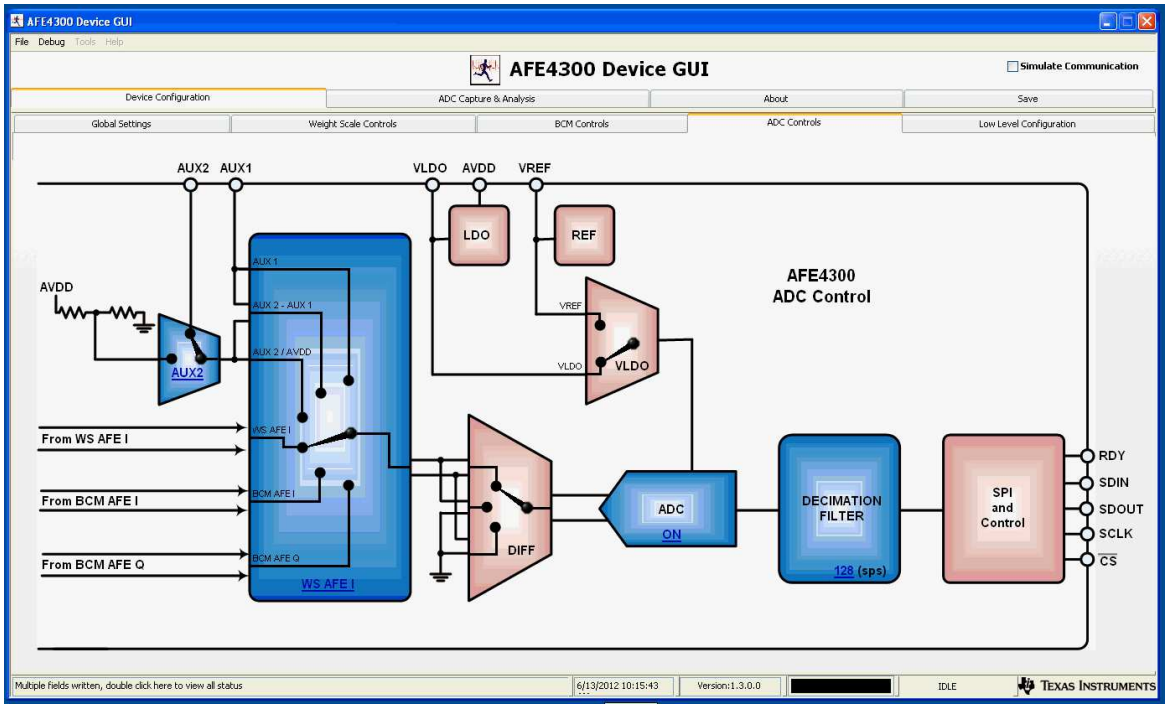

Figure 17. Device Configuration: ADC Controls

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4.1.1.5 Low Level Configuration Subtab

The *Low Level Configuration* subtab under the *Device Configuration* tab is used to directly configure the various registers of the AFE4300 device. Please refer to the AFE4300 data sheet (SBAS586) for the register details of the chip.

Figure 18 shows the low-level configuration registers of the AFE4300 device. The register map portion of this subtab shows the reset values of the registers under the *Default* column, and the EVM default values of the registers after the GUI is loaded under the *EVM Default* column. The *LW** column shows the latest written values of the AFE4300 registers, and the *LR** column shows the latest read values of the AFE4300 registers.

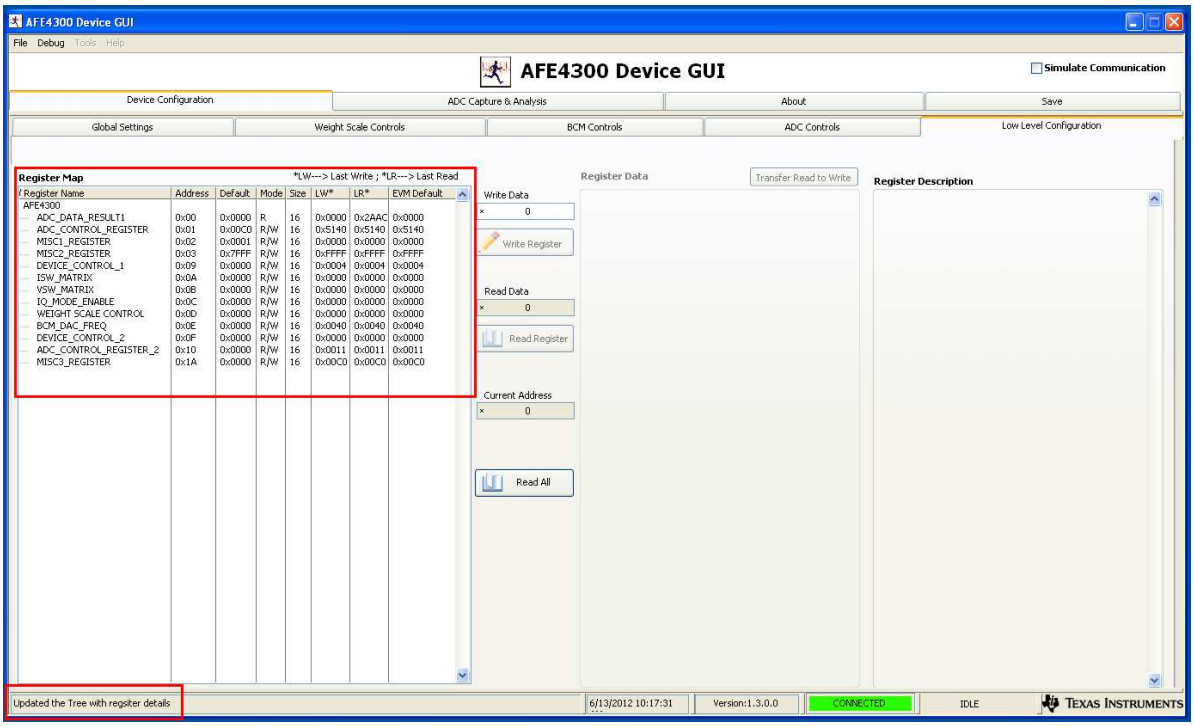

Figure 18. Device Configuration: Low Level Configuration

When a selection is made on any of the tabs on the GUI, multiple fields of various registers are modified. Click on the lower-left corner of the GUI to view the registers that are modified when a selection is made.

NOTE: The AFE4300 device GUI only supports Continuous-Conversion mode. Single-Shot mode is not supported.

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4.1.2 ADC Capture and Analysis

The *ADC Capture and Analysis* tab consists of various analysis routines and displays. This tab is used to:

- Set the capture mode to finite or continuous.
- Set the number of samples (block size) in Finite Capture mode.
- Set the display to volts or codes
- Acquire the data by clicking on the *Capture* button.

The captured data can be analyzed in time domain and frequency domain; the data can also be displayed in a histogram format. The *ADC Capture and Analysis* tab is shown in Figure 19.

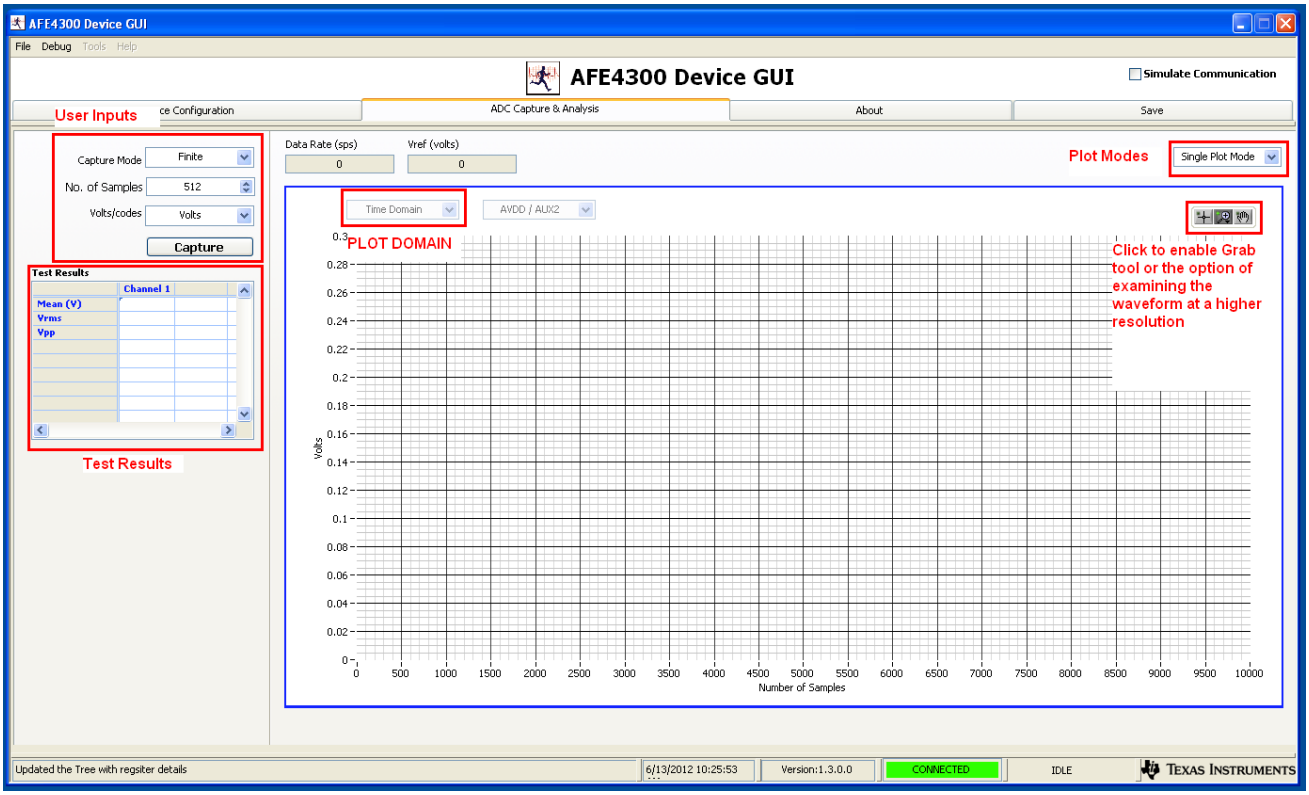

Figure 19. ADC Capture and Analysis Tab

By selecting the *Time Domain* plot, the data are displayed in time domain format. The units can be converted from codes to volts using the drop-down window in the top-left corner of the GUI. For the time domain plot, the mean voltage, root mean square (RMS) voltage, and peak-to-peak voltage are displayed in the *Test Results* section, located on the left side of the GUI.

By selecting the FFT plot, the data are displayed in the frequency domain by performing an FFT on the channel selected. Details of the FFT (including SNR, THD, and so on) are shown in the *Test Results* section located in the left side of the GUI.

Selecting the Histogram plot displays the data in a histogram format for the channel selected. The data are arranged in the total number of histogram bins set within the tab following acquisition. The histogram analysis (shown in the *Test Results* section of the GUI) is used to view the mean voltage, root mean square (RMS) voltage, and peak-to-peak voltage.

Two plot modes can be selected: Single Plot or Double Plot. In Single Plot mode, only one plot (Time, FFT, or Histogram) can be viewed and analyzed for post processing. In Double Plot mode, any two plots (Time, FFT or Histogram) can be viewed and analyzed.

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4.1.3 Save Tab

The *Save* tab shown in Figure 20 provides provisions to save the analysis or data to a file. By default, the data are saved to *C:\Program Files\Texas Instruments\AFE4300 Device GUI\Log*. Use the *Directory to Save Files* option to select the folder where data are to be saved. In the pop-up window, navigate to the folder where the data file is to be saved and select *Use Current Folder*. Then select *Save to File* to save the file.

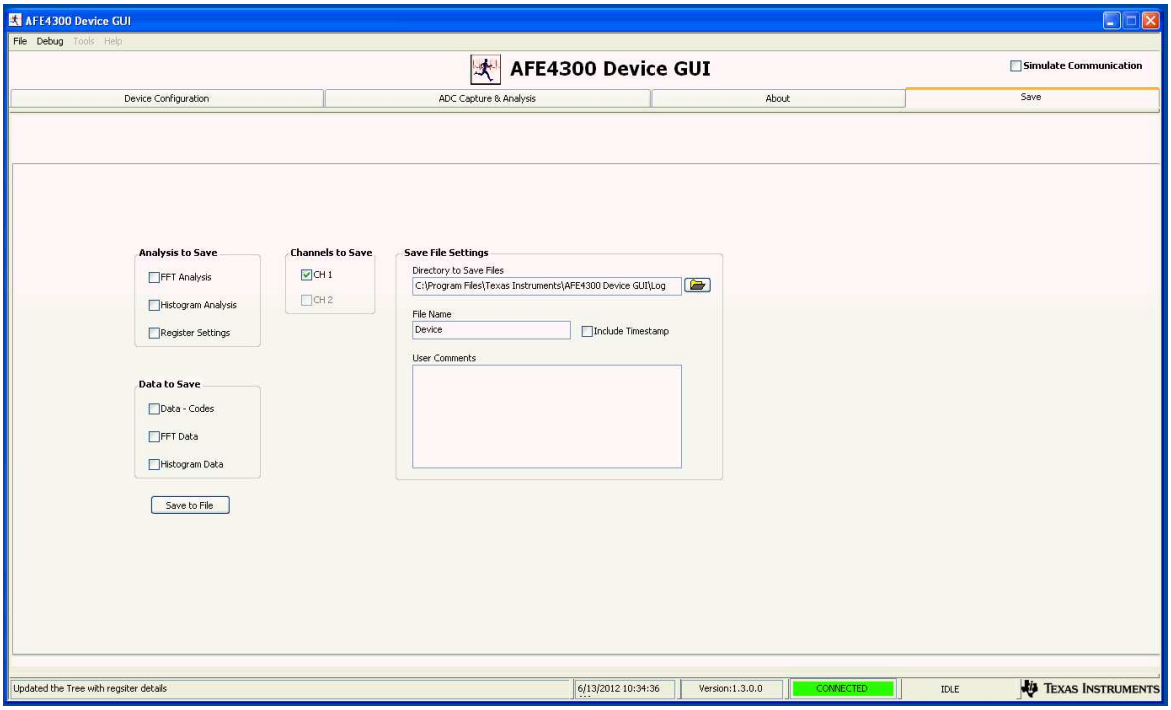

Figure 20. Save Tab

Table 1. Description for the Controls in Save Tab

Button/Control	Description
FFT Analysis	For saving FFT analysis result. The result is saved in the file *Device_"record number"_Analysis.xls*.
Histogram Analysis	For saving histogram analysis result. The result is saved in the file *Device_"record number"_Analysis.xls*.
Register Setting	All the current register values are read from the EVM and stored. The result is saved in the file *Device_"record number"_Analysis.xls*.
Data - Codes	Acquired data sample values are stored to the file *Device_"record number"_Codes.xls*.
FFT Data	Acquired data samples FFT values are stored to the file *Device_"record number"_FFT.xls*.

The *record number* saves files with the provided number in the file name. User notes can also be added to the file by typing the notes in the user comments control.

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5 AFE4300EVM Hardware

CAUTION

Many of the components on the AFE4300EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap, bootstraps, or mats at an approved ESD workstation. Safety glasses should also be worn.

The AFE4300 weight-scale and BCM front-end evaluation board is configured to be used with the MMB3 board, which acts as the data capture card. The key features of the AFE4300 device are:

- Two separate signal chains for weight-scale and BCM analysis.
- Supports up to four load-cell inputs.
- On-chip load-cell 1.7-V excitation voltage for ratiometric measurement.
- Supports up to three tetrapolar complex impedance measurements.
- 16-bit ADC.
- Data rates of 8 SPS to 860 SPS.
- 2-V to 3.6-V digital supply.
- SPI data interface.

The AFE4300EVM is used as a demonstration board for weight-scale and body composition measurement applications. The EVM provides load-cell terminals to support up to four load-cell inputs for weight-scale measurements, BCM terminals to support up to three tetrapolar complex impedance measurements. Any type of single-ended or differential signals can be fed directly to the AFE4300 through the auxiliary (AUX1 and AUX2) inputs. External support circuits, such as an antialiasing network for load-cell terminals, trim-pot for setting the gain of the instrumentation amplifier at the weight-scale front-end, instrumentation amplifiers for the BCM differential terminals, load-cell simulation block, impedance simulation block, clocks, and external references are provided for testing purposes.

Figure 21 shows the functional block diagram for the AFE4300EVM.

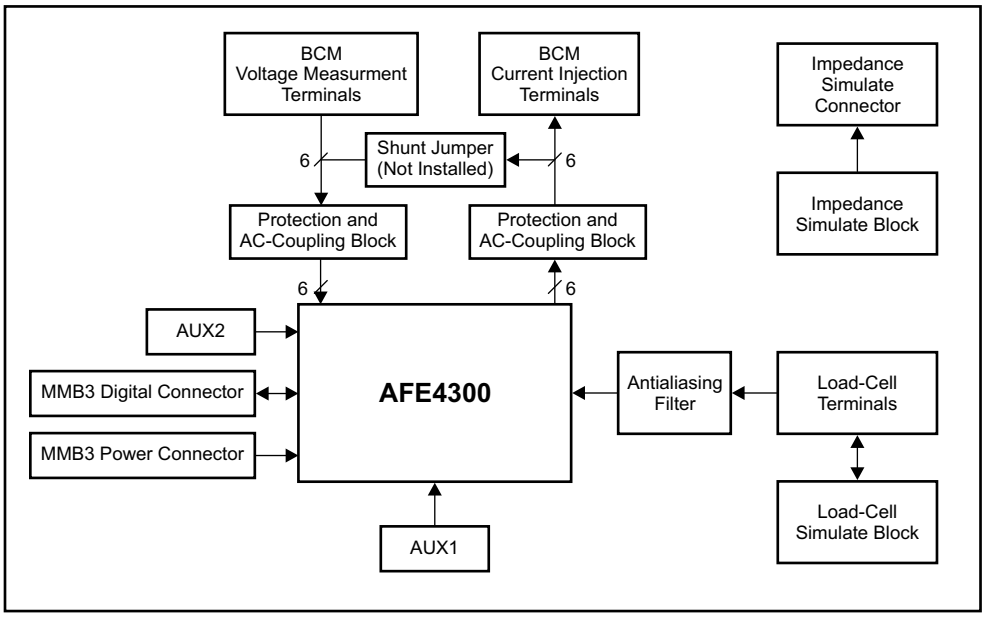

Figure 21. AFE4300EVM Block Diagram

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The AFE4300EVM board is a two-layer circuit board. The board layout is provided in Section B.1, and the schematics are provided in Section B.2. The bill of materials is provided in Appendix A. The following sections explain some of the hardware settings possible with the EVM for the evaluating the AFE4300 under various test conditions.

5.1 Power Supply

The AFE4300EVM mounts on the MMB3 data capture card with connectors J101, J102 and J103 on the AFE4300EVM. The main power supply for the AFE4300EVM is provided by the MMB3 host board through power connector J102 on the AFE4300EVM. The AFE4300 can operate from +2-V to +3.6-V analog supply (AVDD/AVSS). The power consumption of the AFE4300EVM is measured by using the J8 connector. The power consumption of the AFE4300 device can be measured by using the J9 connector.

5.2 Clock

The AFE4300 device requires an external 1-MHz clock signal. The AFE4300EVM provides an option to provide the external 1-MHz clock signal from the MMB3 host board, or through an SMA connector. The AFE4300EVM-PDK is shipped with the clock signal routed from the MMB3 host board.

5.3 Reference

The AFE4300 has an on-chip internal reference circuit and an on-chip, low-dropout regulator (LDO) that provides reference voltages to the device. Alternatively, the internal references can be powered down and references can be applied externally. TP4 is used to measure the reference voltage, V_{REF}. Jumper J54, pin 2 is used to measure VLDO. Table 2 presents the various configurations for the reference voltages.

Table 2. Reference Voltage Configurations

Mode	Register 0x10 [6:5]	VLDO Pin	VREF Pin	ADC Reference
Weight scale enabled	00	1.7 V	Floating	1.7 V (from LDO)
	11	1.7 V	Floating	External reference (applied on VREF pin)
BCM enabled	00	Floating	1.7 V	External reference (applied on VLDO pin)
	11	Floating	1.7 V	1.7 V (from reference)
Both off (AUX measurement)	00	1.7 V	Floating	1.7 V (from LDO)
	11	1.7 V	Floating	External reference (applied on VREF pin)
Both on (Invalid Mode)	—	—	—	—

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5.4 Accessing AFE4300 Digital Signals

The AFE4300 digital signals (including SPI signals and control signals) are available at connector J103. These signals are used to interface to the MMB0-like data capture board. The pinout for this connector is given in Table 3.

Table 3. Digital Connector Pinout

Signal	J103 Pin Number		VREF pin
STE1	1	2	NC
SCLK	3	4	GND
NC	5	6	NC
NC	7	8	RESET_MCU
NC	9	10	GND
SIMO1	11	12	NC
SOMI1	13	14	NC
RDY	15	16	NC
CLK_MCU	17	18	GND
NC	19	20	SDQ

5.5 Onboard Key Interface (Reset)

The AFE4300EVM has one switch. When this switch is pressed, a hard reset is issued to the AFE4300 device setting all the registers to the reset state.

5.6 Connector Interface

Table 4 presents the signal description of the connectors provided for the weight-scale load cell, BCM impedance, and AUX terminals.

Table 4. AFE4300EVM Onboard Connectors

Connector	Signal Description
J56 (1-2)	INP1 / INM1 (Load cell terminal channel 1)
J56 (3-4)	INP2 / INM2 (Load cell terminal channel 2)
J55 (1-2)	INP3 / INM3 (Load cell terminal channel 3)
J55 (3-4)	INP4 / INM4 (Load cell terminal channel 4)
J36 (1-2)	IOUT0 / IOUT1 (Current source output to electrodes)
J38 (1-2)	IOUT2 / IOUT3 (Current source output to electrodes)
J38 (3-4)	IOUT4 / IOUT5 (Current source output to electrodes)
J10 (1-2)	VSENSE0 / VSENSE1 (Input to differential amplifier from electrodes)
J21 (1-2)	VSENSE2 / VSENSE3 (Input to differential amplifier from electrodes)
J21 (2-3)	VSENSE4 / VSENSE5 (Input to differential amplifier from electrodes)
J37 (1-2)	AUX1 / AVSS
J1 (1-2)	AUX2 / AVSS

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6 Getting Started

6.1 Power Up and Connection Setup

The following steps help to guide you through power up and connection of the EVM. Figure 22 shows the hardware setup.

1. Connect the USB cable to the J1 connector on the MMB3 board.
2. For weigh-scale setup:
   (a) To connect external load cells: use connectors J55 or J56 to connect to any or all of the four channels: INP[:03] and INM[3:0].
   (b) To connect the onboard load cell: place shunts between pins 2 and 3 for J46 through J53 to switch to the onboard load cell. Note that by default, the shunts are placed between pins 1 and 2 to enable connection to external load cell terminals.
3. For BCM hardware setup:
   (a) Connect current injection electrodes across IOUT[5:0] terminals (J36 and J38).
   (b) Connect voltage measurement electrodes across VSENSE[5:0] terminals (J10 and J21).

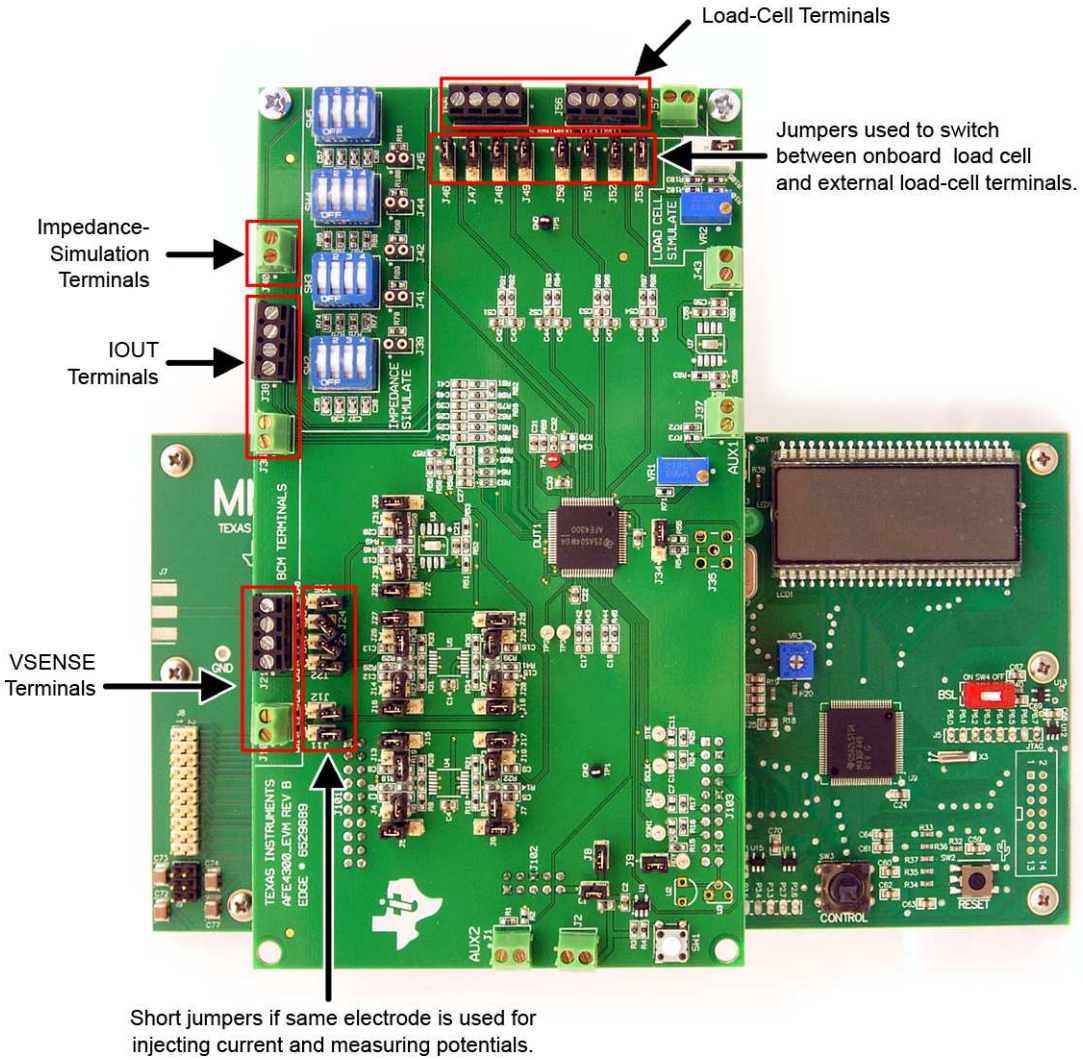

Figure 22. Hardware Setup

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6.2 Weigh-Scale Demonstration Using Onboard Load Cell

This section describes using the onboard load cell to set up the weigh-scale function.

6.2.1 Hardware Setup

Place shunts across J52 and J53 (pins INP1 and INM1) to connect channel 1.

6.2.2 Graphical User Interface (GUI) Settings

The following steps set up the weigh-scale function using the GUI. Figure 23 shows the GUI window with the step numbers highlighted.

1. Click on the *Device Configuration* tab.
2. Then click on the *Weight Scale Control* subtab.
3. Select the INP1 and INM1 channel.
4. Click the *WS ON?* button to enable the weigh-scale function.

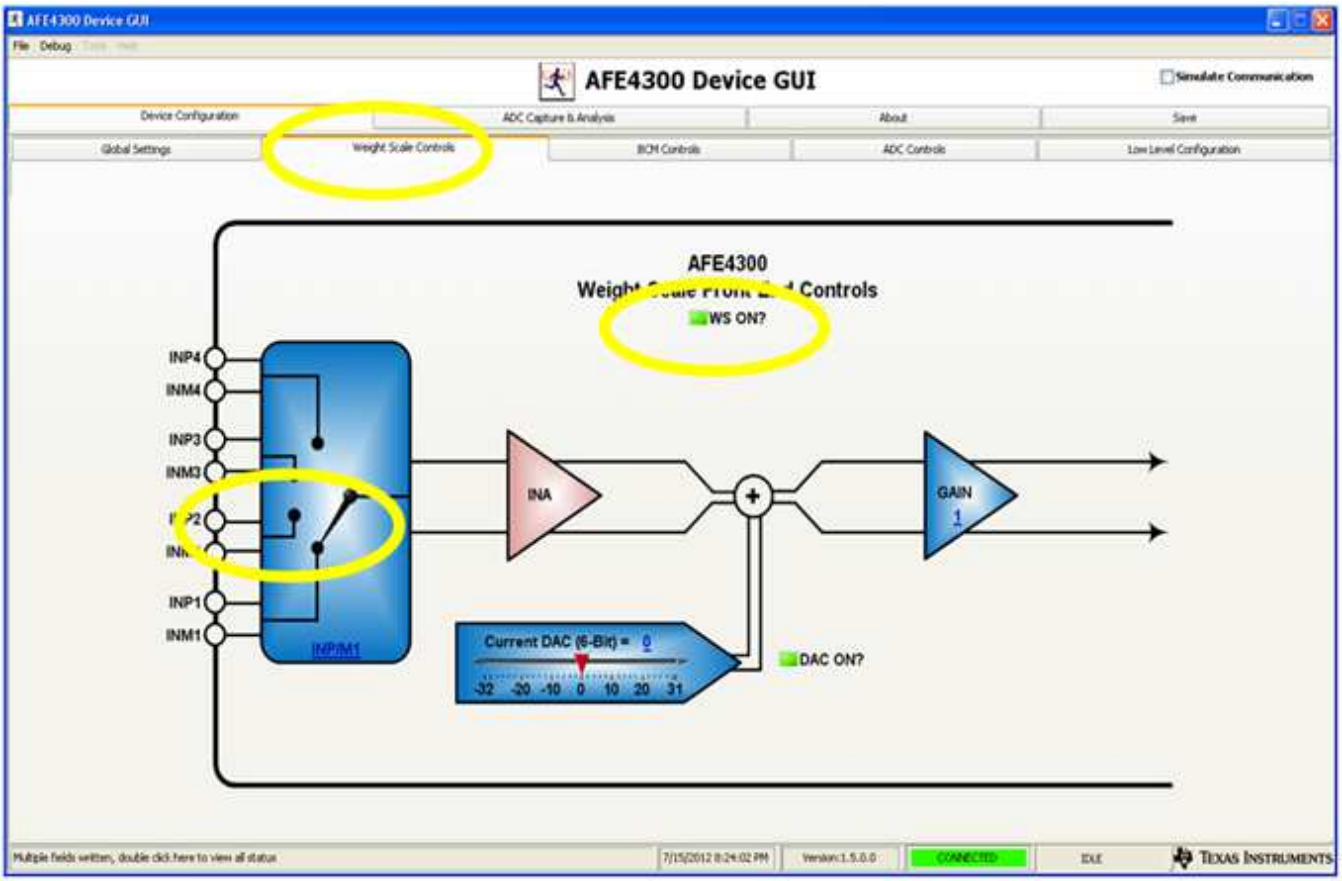

Figure 23. Weigh-Scale GUI Settings

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6.2.3 Weigh-Scale ADC Output Display

This following steps describe how to view the weigh-scale ADC output display, and are highlighted in Figure 24.

1. Click on the *ADC Capture & Analysis* tab.
2. Set the Capture Mode to *Continuous*.
3. Turn on VR2 (refer to attached scematics) to see that the waveform changes in the display window.

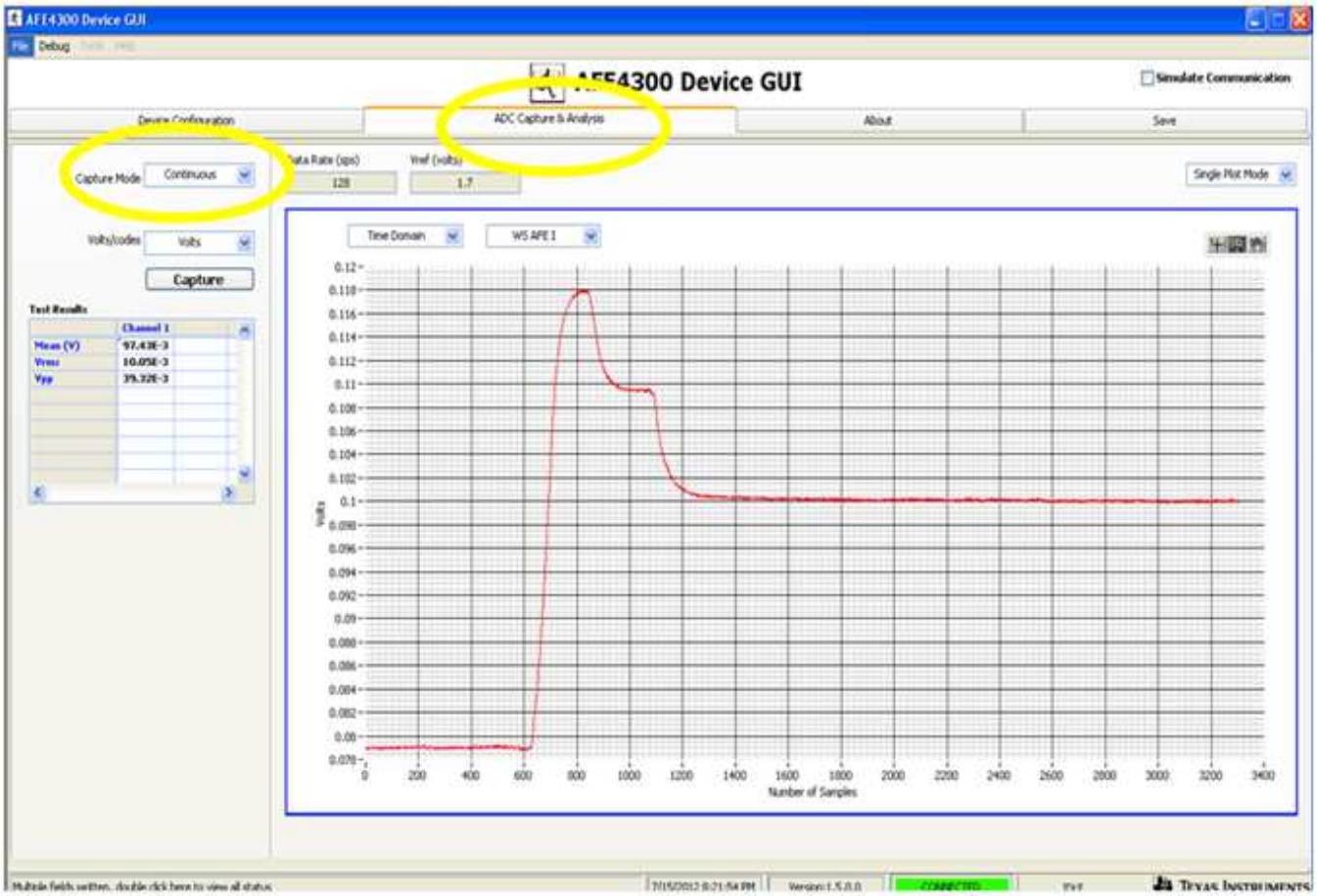

Figure 24. Weigh-Scale ADC Output Display

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6.3 BCM Demonstration Using Onboard Impedance Simulate Block

This section describes how to use the onboard impedance simulate block for body composition measurement.

6.3.1 Hardware Setup

The following steps describe the hardware setup:

1. For demonstration purposes, place shunts across J11, J12, J22, J23, J24, and J25. Connect wires across the impedance simulate terminal and either the IOUT[5:0] or VSENSE[5:0] terminals.
2. Switch (SW3) third position is in the ON position, which simulates a 1-kΩ body impedance resistor between IOUT0 and IOUT1.

6.3.2 GUI Settings

The following steps describe the GUI setup, and are highlighted in Figure 25.

1. Click on the *Device Configuration* tab.
2. Click on *BCM Control* subtab.
3. Select the VSENSE1 terminal using the + dial.
4. Select the VSENSE0 terminal using the – dial.
5. Select the IOUT0 terminal for the FB0 dial.
6. Select the IOUT1 terminal for the FB1 dial.
7. Click the *BCM ON?* button to enable the weight-scale function.

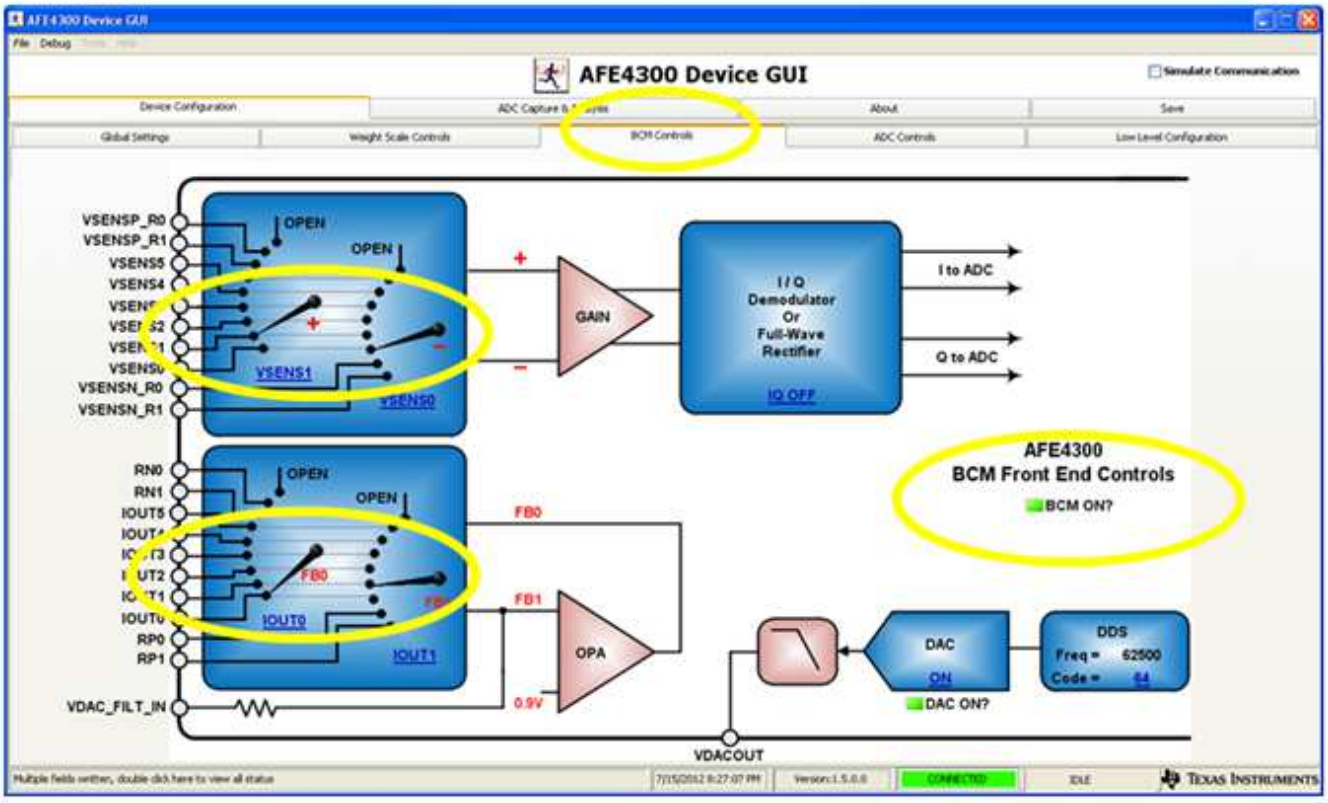

Figure 25. BCM GUI Settings

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6.3.3 BCM ADC Output Display

This following steps describe how to view the BCM ADC output display, and are highlighted in Figure 26.

1. Click on the *ADC Capture & Analysis* tab.
2. Set the Capture Mode to *Continuous*.
3. In the *Test Results* window, check the value in the *Mean (V)* row. For a 1-kΩ body-impedance resistor, the mean volts are approximately 0.69 V.

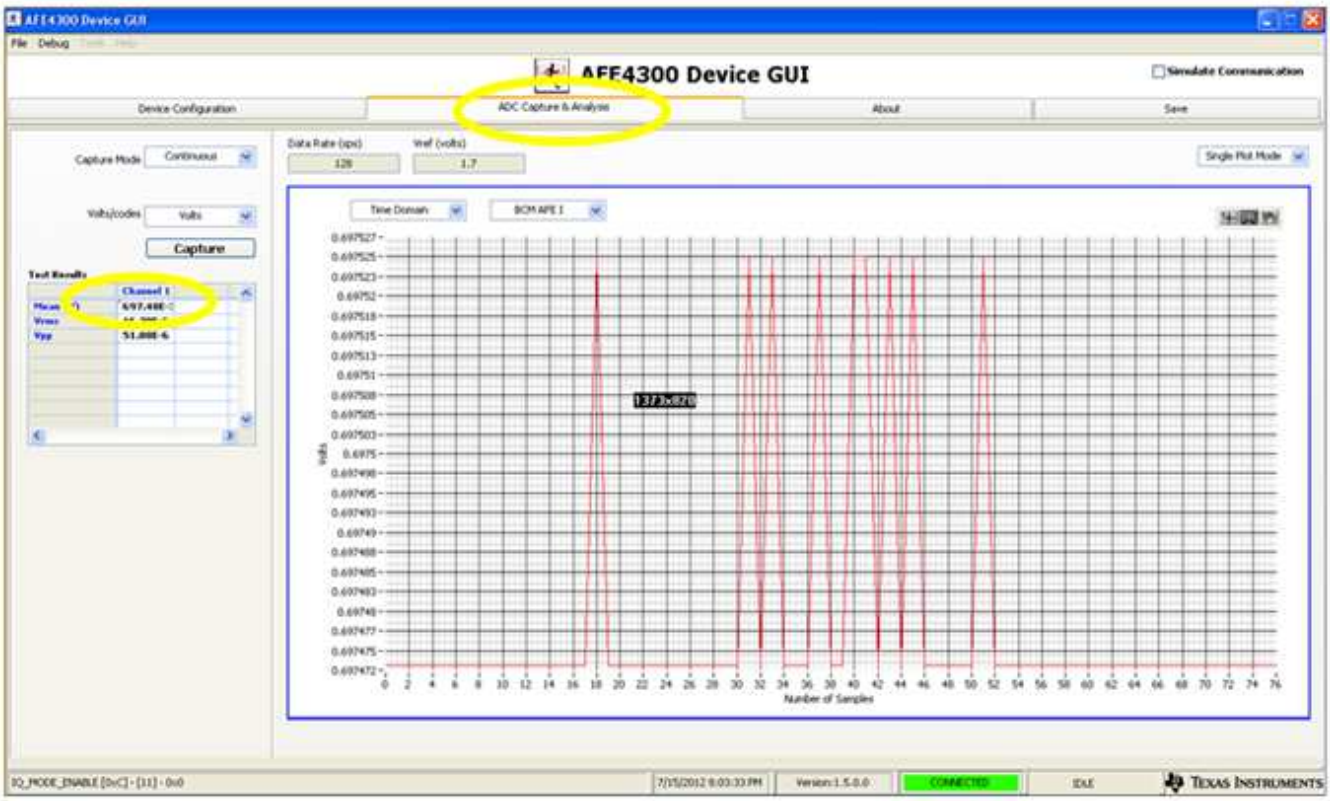

Figure 26. BCM ADC Output Display

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Appendix A Bill of Materials (BOM)

The following pages show the bill of materials table, landscaped for readability.

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Table 5. Bill of Materials

Item	Quantity	Ref Des	Description	Manufacturer	Part Number
1	6	CR1, CR2, CR3, CR4, CR5, CR6	ESD PROTECTION DIODE, DBL ELEMENT, 6A	TI	TPD1E10B06
2	33	C2, C3, C4, C5, C8, C9, C12, C13, C14, C15, C16, C19, C20, C21, C22, C23, C31, C33, C42, C43, C44, C45, C46, C47, C48, C49, C50, C51, C52, C53, C54, C55, C56	CAPACITOR,SMT,0603,CERAMIC,0.1uF,25V,10%,X7R	AVX	06033C104KAT2A
3	4	C6, C7, C10, C11	UNINSTALLED	UNINSTALLED	06033D104KAT2A(UN)
4	8	C35, C36, C37, C38, C57, C58, C59, C60	CAPACITOR,SMT,0603,CERAMIC,100pF,50V,5%,C0G(NP0)	AVX	06035A101JAT2A
5	10	C24, C25, C26, C27, C28, C29, C30, C39, C40, C41	CAPACITOR,SMT,0603,CERAMIC,1.0uF,16V,10%,X5R	AVX	0603YD105KAT2A
6	1	C1	CAPACITOR,SMT,0603,CERAMIC,10uF,6.3V,20%,X5R	PANASONIC	ECJ-1VB0J106M
7	2	C32, C34	CAPACITOR,SMT,0603,CERAMIC,0.47uF,6.3V,10%,X5R	PANASONIC	ECJ-1VB0J474K
8	2	C17, C18	CAPACITOR,SMT,0603,CERAMIC,4.7uF,6.3V,10%,X5R	MURATA	GRM188R60J475KE19D
9	1	J35	SMA COAX STRAIGHT PCB CURRENT P/N IS 901-144-8RFX	AMPHENOL	901-144-8
10	19	J3, J4, J7, J8, J9, J11, J12, J13, J14, J19, J20, J22, J23, J24, J25, J26, J29, J30, J31	HEADER,THU,2P,2X1,MALE,DUAL ROW,100LS,100TL	SAMTEC	TSW-101-07-G-D
11	1	J102	HEADER,THU,10P,FEM,2x5,0.1LS,34OH,115TL,VERTICAL	SAMTEC	ESW-105-44-L-D
12	2	J101, J103	HEADER,THU,20P,FEM,2x10,0.1LS,VERTICAL,115TL,340H	SAMTEC	ESW-110-44-L-D
13	5	J39, J41, J42, J44, J45	HEADER,THU,FEM,0.1LS,2P,1X2,236H,118TL	MILL-MAX	316-93-102-41-006
14	1	J54	4P, VERT, FRICTION LOCK	MOLEX	22-23-2041
15	1	U6	250MHz RAIL-TO-RAIL I/O CMOS OPERATIONAL AMPLIFIERS	TI	OPA2354AIDDA
16	1	U7	250MHz RAIL-TO-RAIL I/O CMOS OPERATIONAL AMPLIFIERS	TI	OPA354AIDDA
17	1	U1	SINGLE 2-INPUT POSITIVE-AND GATE	TI	SN74AHC1G08DBV
18	2	U4, U5	250MHz, RAIL-TO-RAIL I/O,CMOS OPERATIONAL AMPLIFIERS	TI / BURR-BROWN	OPA4354AIPW
19	19	J5, J6, J15, J16, J17, J18, J27, J28, J32, J33, J34, J46, J47, J48, J49, J50, J51, J52, J53	INSTALLED JUMPER,THU,3P .100cc,123	ANY	JUMPER,3P .100cc 123
20	22	R5, R7, R13, R14, R18, R22, R26, R28, R29, R38, R39, R41, R46, R48, R49, R63, R64, R65, R66, R67, R68, R82	RESISTOR,SMT,0603,THICK FILM,10M,1%,1/10W	YAGEO	9C06031A1005FKHFT
21	31	R1, R6, R12, R16, R17, R19, R23, R24, R25, R27, R30, R37, R40, R42, R43, R44, R45, R47, R50, R54, R60, R61, R62, R69, R73, R78, R79, R80, R81, R99, R101	RESISTOR,SMT,0603,0603,1/10W,0 OHM,ZERO OHM	VISHAY	CRCW0603000Z
22	5	R4, R76, R102, R103, R105	RESISTOR,SMT,0603,1%,1/10W,1.00K	VISHAY	CRCW06031001F

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Table 5. Bill of Materials (continued)

Item	Quantity	Ref Des	Description	Manufacturer	Part Number
23	11	R3, R15, R57, R91, R92, R93, R94, R95, R96, R97, R98	RESISTOR,SMT,0603,1%,1/10W,10.0K	VISHAY	CRCW06031002F
24	2	R58, R86	RESISTOR,SMT,0603,1%,1/10W,100 OHM	VISHAY	CRCW0603100F
25	1	R85	RESISTOR,SMT,0603,1%,1/10W,10 OHM	VISHAY	CRCW060310F
26	1	R77	RESISTOR,SMT,0603,1%,1/10W,1.50K	VISHAY	CRCW06031501F
27	5	R9, R11, R32, R35, R52	RESISTOR,SMT,0603,1%,1/10W,150K	VISHAY	CRCW06031503F
28	2	R71, R88	RESISTOR,SMT,0603,1%,1/10W,499 OHM	VISHAY	CRCW0603499F
29	1	R74	RESISTOR,SMT,0603,1%,1/10W,604 OHM	VISHAY	CRCW0603604F
30	12	R8, R10, R20, R21, R31, R33, R34, R36, R51, R53, R83, R84	RESISTOR,SMT,0603,1%,1/10W,75.0K	VISHAY	CRCW06037502F
31	2	R56, R75	RESISTOR,SMT,0603,1%,1/10W,750 OHM	VISHAY	CRCW0603750F
32	1	R104	RESISTOR,SMT,0603,1%,1/10W,976 OHM	VISHAY	CRCW0603976F
33	1	R59	RESISTOR,SMT,0603,200 OHM,0.1%,1/10W	PANASONIC	ERA-3YEB201V
34	1	R87	RESISTOR,SMT,0603,5%,1/10W,300	PANASONIC	ERJ-3GSYJ301
35	1	R55	RESISTOR,SMT,0603,50.0 OHM,0.1%,1/8W	VISHAY	FC0603E50R0BTBST1
36	4	SW2, SW3, SW4, SW5	SWITCH, SPST, DIP8	AMP	3-435668-4
37	1	SW1	SWITCH,SMT,4P,SPST-NO,TOP-PUSH,4.3mm HEIGHT	PANASONIC	EVQ-PAD04M
38	8	J1, J2, J10, J36, J37, J40, J43, J57	TERMINAL BLOCK,THU,2 POSITION,137TL,323H	ON-SHORE TECHNOLOGY	ED555/2DS
39	4	J21, J38, J55, J56	TERMINAL BLOCK,THU,4 POSITION,137TL,323H	ON-SHORE TECHNOLOGY	ED555/4DS
40	1	VR1	TRIMPOT,THU,10K,10%,0.5W,100ppm,25T	BOURNS	3296W-1-103
41	1	VR2	TRIMPOT,THU,50 OHM,10%,0.5W,100ppm,25T	BOURNS	3296W-1-500
42	6	R2, R70, R72, R89, R90, R100	UNINSTALLED	UNINSTALLED	CRCW060349R9F(UN)
43	5	U2,U3	DIA_038, PIN_013-020, EXP_146, B125	TYCO	50935
44	1	DUT1	QFP 80 PFC PKG (Customer Supply)	TI	AFE4300
45	2	TP1, TP5	TESTPOINT,THU,MINIATURE,0.1LS,120TL, BLACK	KEYSTONE ELECTRONICS	5001
46	7	RDY,STE,TP2, TP3,SCLK,SIMO,SOMI	TESTPOINT,THU,MINIATURE,0.1LS,120TL, WHITE	KEYSTONE ELECTRONICS	5002
47	1	TP4	TESTPOINT,THU,MINIATURE,0.1LS,120TL, RED	KEYSTONE ELECTRONICS	5000

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Appendix B PCB Layout and Schematics

B.1 PCB Layout

The following pages show the PCB layout, landscaped for readability.

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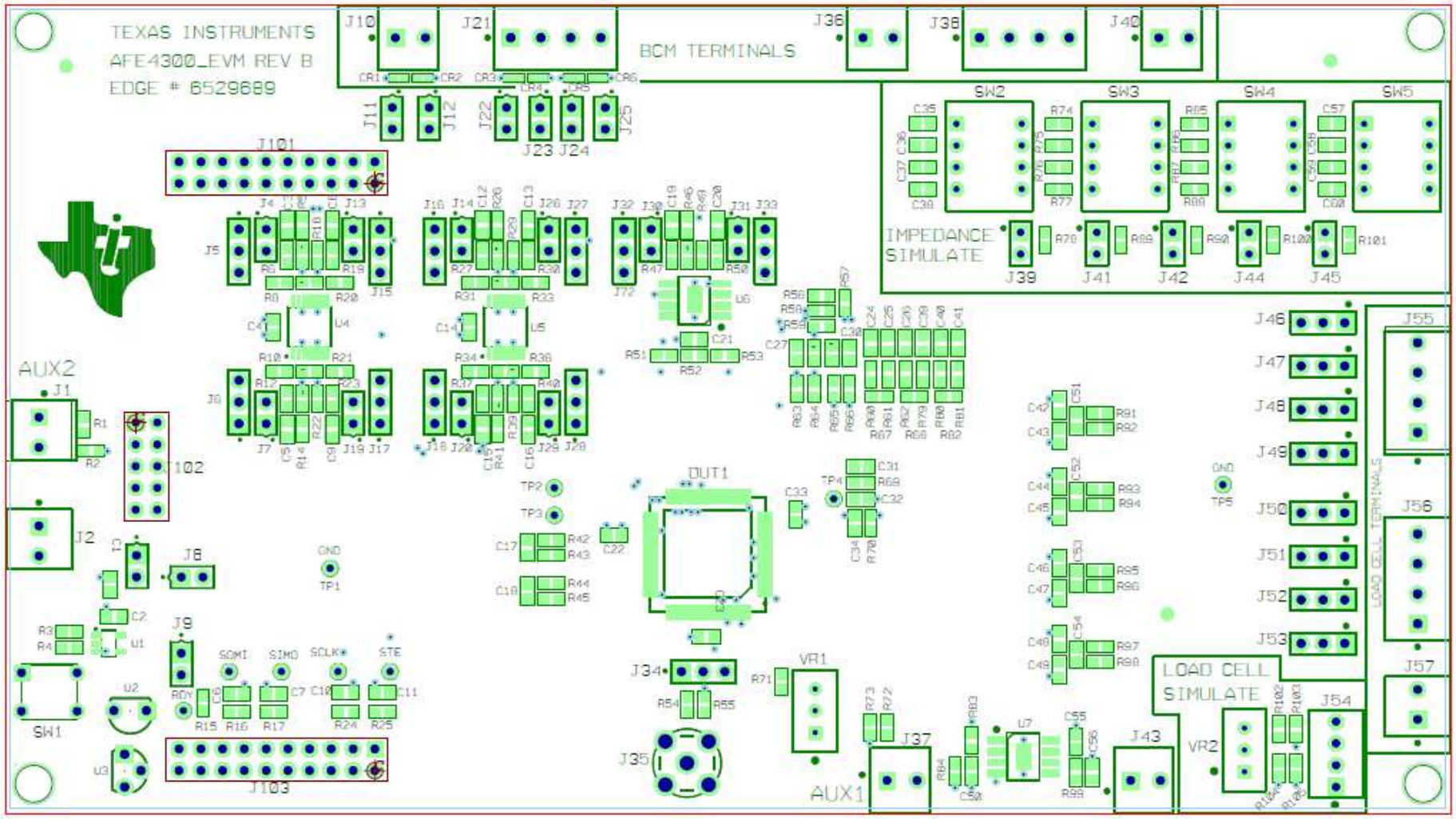

Figure 27. Top Layer Placement

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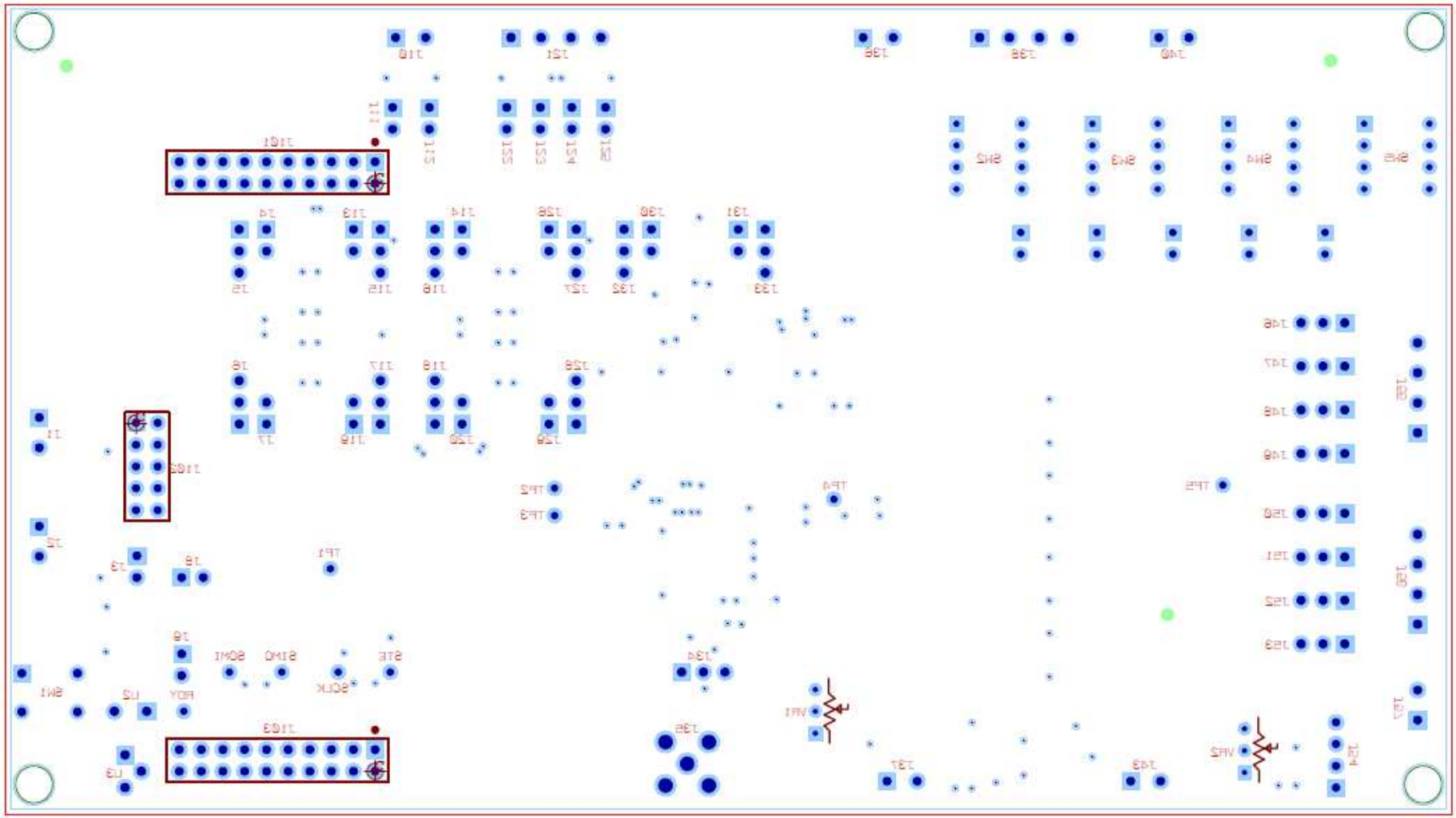

Figure 28. Bottom Layer Placement

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B.2 Schematics

The schematics are appended to the end of this user's guide.

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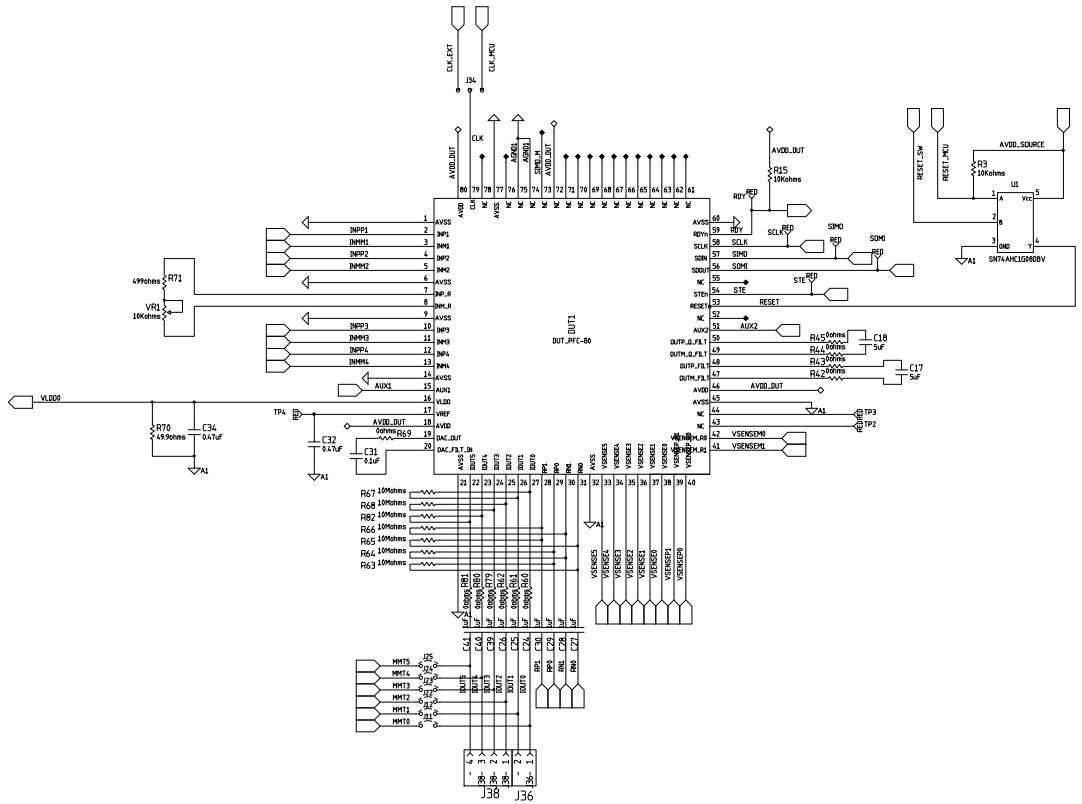


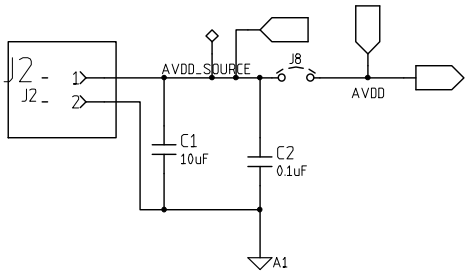
SYM	REVISIONS
B	ECR 2122895 03/16/2012 .TGR

DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS
DESIGNER: P. Aroul	DATE 03/16/2012	CODE IDENTITY NUMBER 01295
CHECKER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC AFE4300 EVM
ENGINEER: P. Aroul	DATE 03/16/2012	
APPROVED: P. Aroul	DATE 03/16/2012	
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N · SIZE D · 6529689 · REV B · SHEET 1 OF 7

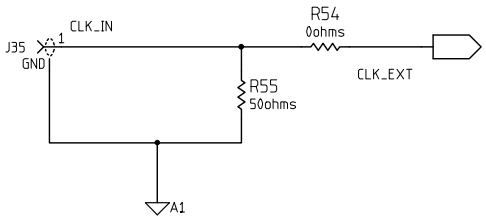
H=4ND; V=4LA

REV	REVISIONS
B	ECR 212289503/16/2012,TGR

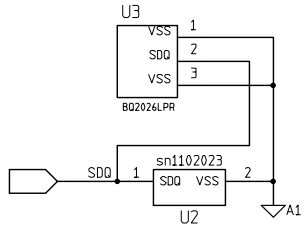
POWER SUPPLY



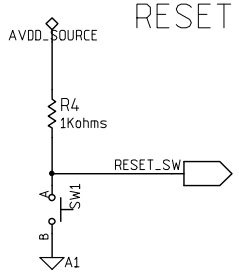
INPUT CLOCK



EPROM



RESET



DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS	CODE IDENTITY NUMBER 01295
DESIGNER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC, AFE4300 EVM	
CHECKER: P. Aroul	DATE 03/16/2012		
ENGINEER: P. Aroul	DATE 03/16/2012		
APPROVED: P. Aroul	DATE 03/16/2012		
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N / B SIZE / 6529689	B REV / SHEET 03 / 07

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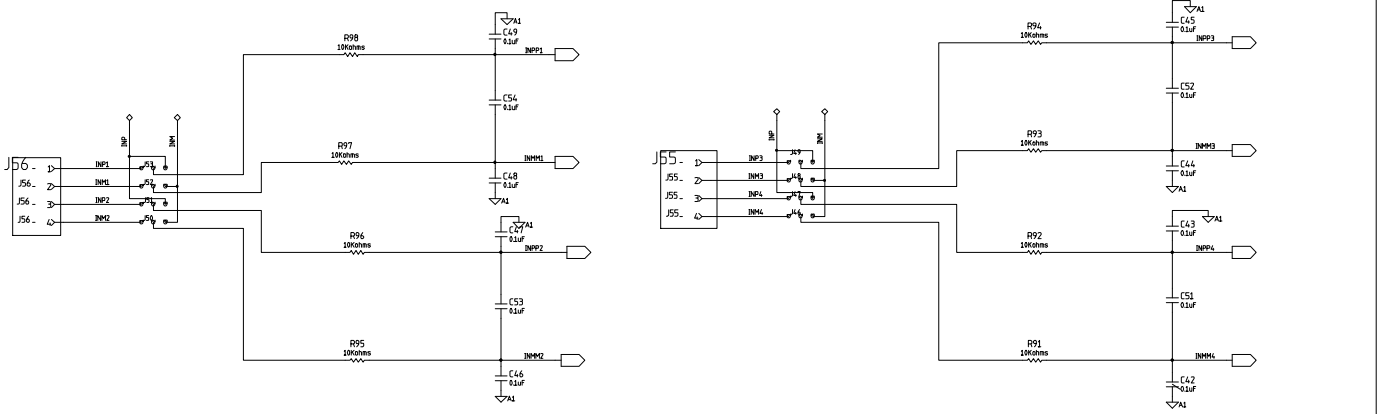
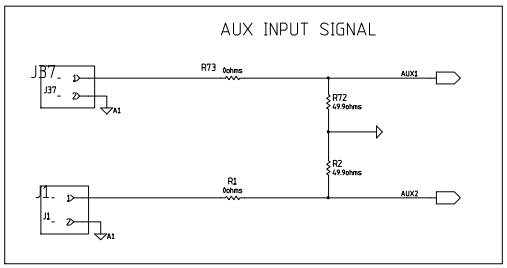
B	ECR 2122895 03/16/2012 ,TGR

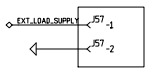
WEIGH SCALE INPUT SIGNAL



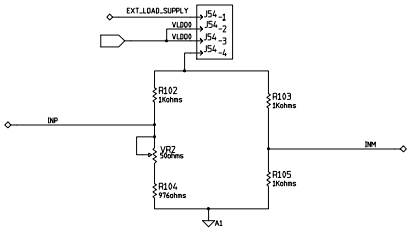
AUX INPUT SIGNAL



EXT_LOAD_SUPPLY_GND



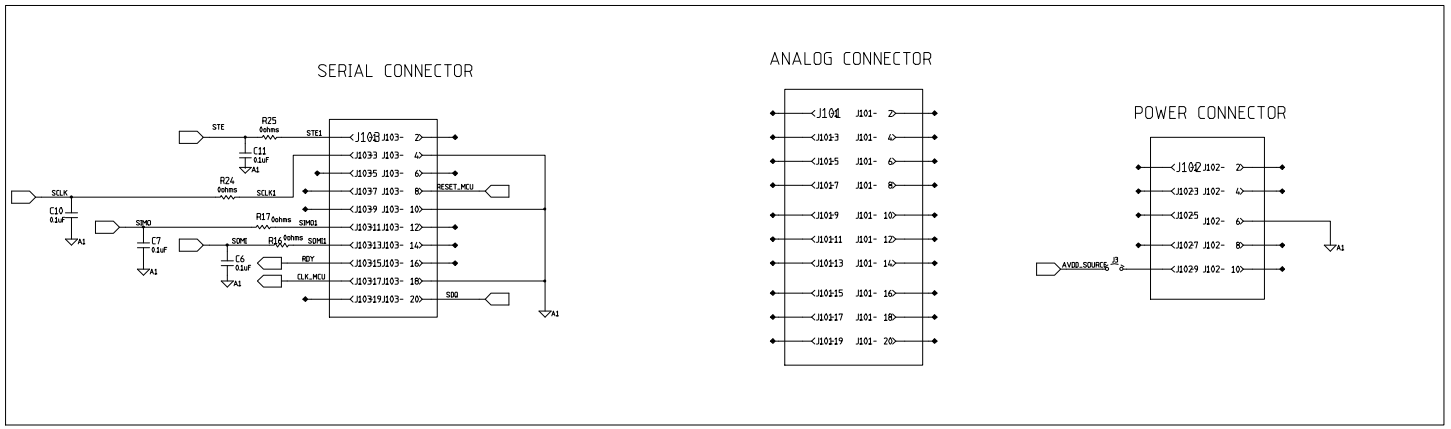
SIMULATION LOAD CELL



DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS		CODE IDENTITY NUMBER 01295	
DESIGNER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC AFE4300 EVM			
CHECKER: P. Aroul	DATE 03/16/2012				
ENGINEER: P. Aroul	DATE 03/16/2012				
APPROVED: P. Aroul	DATE 03/16/2012				
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N	D SIZE 6529689	B REV	SHEET 04 OF 07

H=4ND; V=4LA

SYM	REVISIONS
B	ECR 2122895 03/16/2012 ,TGR



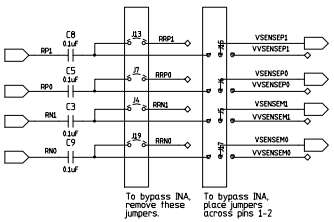
DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS	CODE IDENTITY NUMBER 01295
DESIGNER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC, AFE4300 EVM	
CHECKER: P. Aroul	DATE 03/16/2012		
ENGINEER: P. Aroul	DATE 03/16/2012		
APPROVED: P. Aroul	DATE 03/16/2012		
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N / D SIZE / 6529689 / B REV / SHEET 05 OF 07	

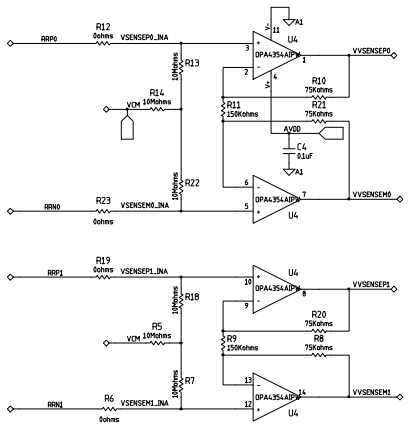
H=4ND; V=4LA

SYM	REVISIONS
B	ECR 2122895 03/16/2012 ,TGR

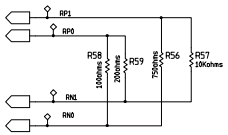
RECEIVE - CALIBRATION RESISTORS

INA BYPASS

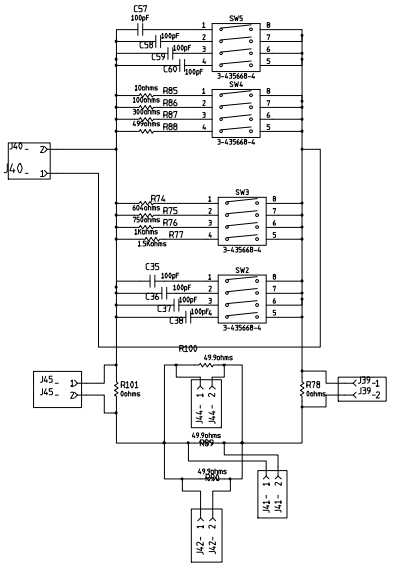




REFERENCE RESISTOR



IMPEDANCE MEASUREMENT



DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS	CODE IDENTITY NUMBER 01295
DESIGNER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC AFE4300 EVM	
CHECKER: P. Aroul	DATE 03/16/2012		
ENGINEER: P. Aroul	DATE 03/16/2012		
APPROVED: P. Aroul	DATE 03/16/2012		
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N / D SIZE 6529689	B REV / SHEET 06 OF 07

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SYM	REVISIONS
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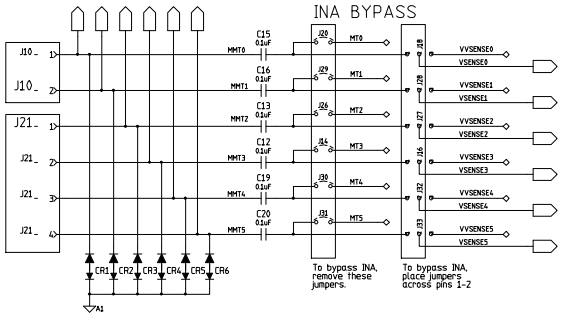
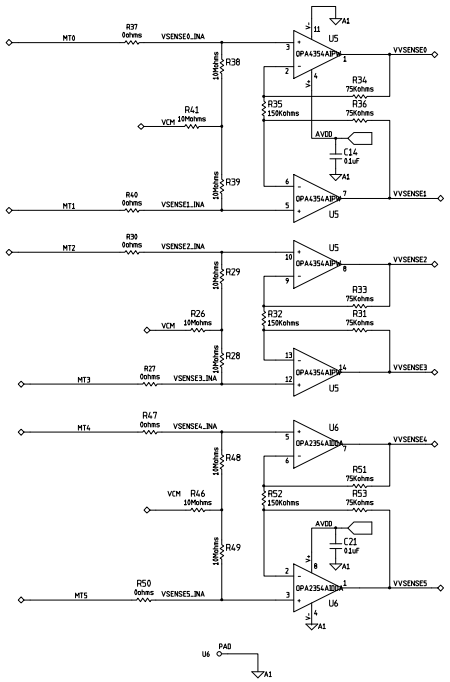
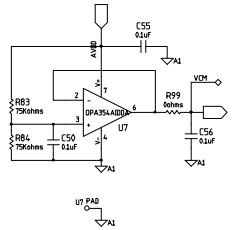
RECEIVE BCM NETWORK





VCM GENERATION



DRAFTSMAN: P. Aroul	DATE 03/16/2012	TEXAS INSTRUMENTS SEMICONDUCTOR OPERATIONS
DESIGNER: P. Aroul	DATE 03/16/2012	CODE IDENTITY NUMBER 01295
CHECKER: P. Aroul	DATE 03/16/2012	TITLE: SCHEMATIC, AFE4300 EVM
ENGINEER: P. Aroul	DATE 03/16/2012	
APPROVED: P. Aroul	DATE 03/16/2012	
RELEASED: T. Reinert	DATE 03/16/2012	SCALE N, D SIZE, 6529689, B REV, SHEET 07 OF 07

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Revision History

Changes from Original (June 2012) to A Revision **Page**

- Changed all instances of "MSP430L110EVM" to "MMB3 board." 5
- Changed all instances of "USB-to-mini USB cable" to "USB cable." 5
- Added *Getting Started* section 26
- Updated BOM 31

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

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Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than +30°C. The EVM is designed to operate properly with certain components above +30°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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